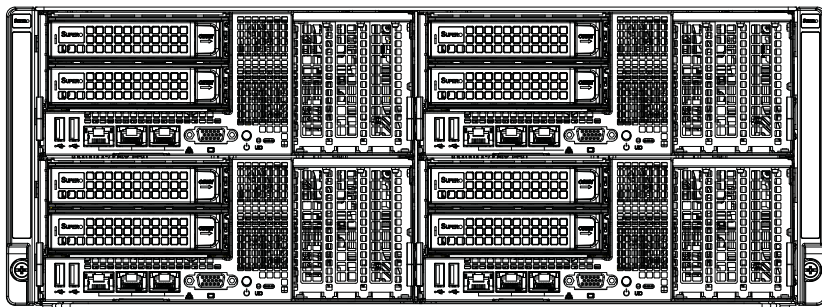


SUPERO®

FatTwin
F627G3-FT+
F627G3-FTPT+
F627G3-F73+
F627G3-F73PT+



USER'S MANUAL

Revision 1.0d

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Revision 1.0d

Release Date: April 24, 2014

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Preface

About This Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the FatTwin™ F627G3-FT+/FTPT+/F73+/F73PT+. Installation and maintenance should be performed by experienced technicians only.

The FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ is a high-end server based on the F424AG-R1K62B 4U rackmount chassis and a dual processor X9DRFF-iG+/iTG+/7G+/7TG+ serverboard. All models have four IPMI LAN port and eight serverboard nodes with two (2) hot-swap 3.5" SAS or SATA Hard Disk Drives (HDD) each per node. The F627G3-F73+ and F627G3-F73PT+ servers have SAS2 instead of SATA drives, while both the F627G3-FTPT+ and F627G3-F73PT+ servers use 10-Gigabit LAN ports instead of Gigabit LAN ports.

Manual Organization

Chapter 1: Introduction

The first chapter provides a checklist of the main components included with the server system and describes the main features of the X9DRFF-iG+/iTG+/7G+/7TG+ serverboards and the F424AG-R1K62B chassis.

Chapter 2: Server Installation

This chapter describes the steps necessary to install the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ into a rack and check out the server configuration prior to powering up the system. If your server was ordered without processor and memory components, this chapter will refer you to the appropriate sections of the manual for their installation.

Chapter 3: System Interface

Refer here for details on the system interface, which includes the functions and information provided by the control panel on the chassis as well as other LEDs located throughout the system.

Chapter 4: Standardized Warning Statements for AC Systems

You should thoroughly familiarize yourself with this chapter for a general overview of safety precautions that should be followed when installing and servicing the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+.

Chapter 5: Advanced Serverboard Setup

Chapter 5 provides detailed information on the X9DRFF-iG+/iTG+/7G+/7TG+ serverboards, including the locations and functions of connections, headers and jumpers. Refer to this chapter when adding or removing processors or main memory and when reconfiguring the serverboard.

Chapter 6: Advanced Chassis Setup

Refer to Chapter 6 for detailed information on the F424AG-R1K62B server chassis. You should follow the procedures given in this chapter when installing, removing or reconfiguring SATA or peripheral drives and when replacing system power supply units and cooling fans.

Chapter 7: BIOS

The BIOS chapter includes an introduction to BIOS and provides detailed information on running the CMOS Setup Utility.

Appendix A: BIOS Error Beep Codes

Appendix B: System Specifications

Notes

Table of Contents

Chapter 1 Introduction

| | | |
|-----|---|-----|
| 1-1 | Overview | 1-1 |
| 1-2 | Serverboard Features | 1-2 |
| | Processors | 1-2 |
| | Memory | 1-2 |
| | Onboard SAS | 1-2 |
| | Onboard Serial ATA | 1-2 |
| | PCI Expansion Slots | 1-3 |
| | I/O Ports | 1-3 |
| | Graphics Controller | 1-3 |
| | Nuvoton WPCM450 Controller | 1-3 |
| | WPCM450R DDR2 Memory Interface | 1-3 |
| | WPCM450R PCI System Interface | 1-4 |
| | Other Features Supported by the WPCM BMC Controller | 1-4 |
| | Power Supply | 1-4 |
| | Super I/O | 1-4 |
| 1-3 | Server Chassis Features | 1-5 |
| | System Power | 1-5 |
| | SAS/SATA Subsystem | 1-5 |
| | I/O Ports | 1-5 |
| | Cooling System | 1-5 |
| | Air Shrouds | 1-5 |
| | Mounting Rails | 1-6 |
| 1-4 | Advanced Power Management | 1-6 |
| | Intel® Intelligent Power Node Manager (NM) | 1-6 |
| | Manageability Engine (ME) | 1-6 |
| 1-5 | Contacting Supermicro | 1-8 |
| 1-6 | Fat Twin: System Notes | 1-9 |
| | Nodes | 1-9 |
| | System Power | 1-9 |
| | SAS/SATA Backplane/Drives | 1-9 |

Chapter 2 Server Installation

| | | |
|-----|--------------------------------|-----|
| 2-1 | Overview | 2-1 |
| 2-2 | Unpacking the System | 2-1 |
| 2-3 | Preparing for Setup | 2-1 |
| 2-4 | Warnings and Precautions | 2-2 |

| | |
|---|------|
| Choosing a Setup Location..... | 2-2 |
| Rack Precautions | 2-2 |
| Server Precautions..... | 2-2 |
| Rack Mounting Considerations | 2-3 |
| Ambient Operating Temperature | 2-3 |
| Reduced Airflow | 2-3 |
| Mechanical Loading | 2-3 |
| Circuit Overloading..... | 2-3 |
| Reliable Ground | 2-4 |
| 2-5 Rack Mounting Instructions..... | 2-4 |
| Identifying the Sections of the Rack Rails | 2-4 |
| Adjusting the Rails | 2-4 |
| Locking Tabs | 2-5 |
| Installing the Rails on a Rack | 2-6 |
| Chassis Installation | 2-7 |
| 2-6 Checking the Serverboard Setup..... | 2-8 |
| 2-7 Checking the Drive Bay Setup..... | 2-9 |
| Chapter 3 System Interface | |
| 3-1 Overview | 3-1 |
| 3-2 SCF424 Rear I/O Control Panel | 3-1 |
| Control Panel Buttons | 3-2 |
| 3-3 Drive Carrier LEDs..... | 3-3 |
| SAS/SATA Drives | 3-3 |
| SCSI Drives..... | 3-3 |
| Chapter 4 Standardized Warning Statements for AC Systems | |
| 4-1 About Standardized Warning Statements..... | 4-1 |
| Warning Definition | 4-1 |
| Installation Instructions..... | 4-4 |
| Circuit Breaker | 4-5 |
| Power Disconnection Warning | 4-6 |
| Equipment Installation..... | 4-8 |
| Restricted Area..... | 4-9 |
| Battery Handling..... | 4-10 |
| Redundant Power Supplies | 4-12 |
| Backplane Voltage | 4-13 |
| Comply with Local and National Electrical Codes | 4-14 |
| Product Disposal | 4-15 |
| Hot Swap Fan Warning..... | 4-16 |

| | |
|----------------------------------|------|
| Power Cable and AC Adapter | 4-18 |
|----------------------------------|------|

Chapter 5 Advanced Motherboard Setup

| | | |
|------|--|------|
| 5-1 | Handling the Motherboard | 5-1 |
| | Precautions | 5-1 |
| | Unpacking | 5-1 |
| 5-2 | Connecting Cables | 5-2 |
| | Connecting Power Cables | 5-2 |
| | Connecting Data Cables | 5-2 |
| 5-3 | Control Panel Connectors and I/O Ports | 5-3 |
| 5-4 | Processor and Heatsink Installation..... | 5-4 |
| | Installing a CPU Heatsink | 5-8 |
| | Removing the Heatsink..... | 5-8 |
| 5-5 | Installing Memory..... | 5-9 |
| | Removing Memory Modules | 5-10 |
| | Memory Support..... | 5-10 |
| 5-6 | Serverboard Details | 5-16 |
| 5-7 | Connector Definitions..... | 5-19 |
| 5-8 | Jumper Settings | 5-23 |
| | Explanation of Jumpers | 5-23 |
| 5-9 | Onboard Indicators..... | 5-25 |
| 5-10 | Serial ATA Connections..... | 5-27 |
| 5-11 | Installing Drivers..... | 5-28 |
| | SuperDoctor III | 5-29 |
| 5-12 | Serverboard Battery | 5-31 |

Chapter 6 Advanced Chassis Setup

| | | |
|-----|--|------|
| 6-1 | Static-Sensitive Devices..... | 6-1 |
| | Precautions | 6-1 |
| | Unpacking | 6-1 |
| 6-2 | Control Panel | 6-2 |
| 6-3 | Removing the Power Cord..... | 6-3 |
| 6-4 | Removing Nodes from the Chassis | 6-3 |
| 6-5 | Installing and Removing Hard Drives | 6-4 |
| | Removing Hard Drives from the Front of the Node..... | 6-5 |
| | Installing 3.5" Hard Drives into the Drive Carriers..... | 6-6 |
| 6-6 | Node Configurations | 6-8 |
| 6-7 | Removing the Node Cover..... | 6-9 |
| 6-8 | Removing and Installing the Backplane..... | 6-10 |
| | Removing the Backplane | 6-10 |

| | | |
|------|--|------|
| | Installing the Backplane | 6-11 |
| 6-9 | Power Distributor Board Replacement..... | 6-12 |
| 6-10 | Installing the Motherboard | 6-14 |
| | Compatible Motherboards..... | 6-14 |
| | Permanent and Optional Standoffs..... | 6-14 |
| 6-11 | Installing Front and Rear Expansion Cards..... | 6-16 |
| | PCIE Slot Setup | 6-16 |
| | F424AG PCIE Slot Configurations..... | 6-16 |
| | Installing a Low-Profile Expansion Card..... | 6-17 |
| 6-12 | Installing Internal GPUs | 6-18 |
| | Installing Front 10.5" GPUs into the GPU Bracket | 6-18 |
| | Installing a Front 10.5" GPU into the Node | 6-20 |
| | Installing Rear 13" GPUs into the Node | 6-20 |
| | Installing Rear 13" GPUs into a Node | 6-22 |
| 6-13 | Installing the Air Shroud..... | 6-23 |
| | Air Shrouds | 6-23 |
| 6-14 | Checking the Airflow | 6-24 |
| | Installation Complete..... | 6-24 |
| 6-15 | Replacing System Fans | 6-25 |
| 6-16 | Replacing the Power Supply..... | 6-26 |
| | Power Supply Replacement..... | 6-26 |

Chapter 7 BIOS

| | | |
|-----|--|------|
| 7-1 | Introduction..... | 7-1 |
| | Starting BIOS Setup Utility..... | 7-1 |
| | How To Change the Configuration Data | 7-2 |
| | Starting the Setup Utility | 7-2 |
| 7-2 | Main Setup | 7-2 |
| 7-3 | Advanced Setup Configurations..... | 7-3 |
| 7-4 | Event Logs | 7-23 |
| 7-5 | IPMI..... | 7-25 |
| 7-6 | Boot..... | 7-27 |
| 7-7 | Security | 7-28 |
| 7-8 | Save & Exit | 7-29 |

Appendix A System Specifications

Notes

Chapter 1

Introduction

1-1 Overview

The FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ is a high-end server comprised of two main subsystems: the F424AG-R1K62B 4U server chassis and the X9DRFF-iG+/iTG+/7G+/7TG+ dual processor serverboard in four hot-swap nodes. Please refer to our web site for information on operating systems that have been certified for use with the system (www.supermicro.com).

In addition to the serverboard and chassis, various hardware components have been included with the SuperServer F627G3-FT+/FTPT+/F73+/F73PT+ server, as listed below:

- Heatsinks:
 - Four (4) 1U passive CPU heat sinks with narrow ILM (SNK-P0047PS)
 - Four (4) 1U passive CPU heat sinks for 1U GPU server (SNK-P0047PSC)
- Power Adapter Boards:
 - Four (4) FatTwin power adapter boards (BPN-ADP-F418L-O-P)
 - Four (4) FatTwin 2U GPU power adapter boards (BPN-ADP-2UGPU-O-P)
- SATA Backplane:
 - Four (4) backplanes each for two (2) hot-swap 3.5" HDD (BPN-SAS-F424-A2)
 - Eight (8) 21-cm 30AWG SATA S-S cables (CBL-0473L)
 - Four (4) 40-cm and 45-cm 18AWG 8-pin male to two 4-pin male power cables (CBL-0460L-02)
 - Eight black hot swap 3.5" HDD trays (MCP-220-00094-0B)
- Riser Cards:
 - Four (4) riser cards (RSC-R2UFF-2E16B-O-P)
 - Four (4) riser cards (RSC-R2UFF-E16A-O-P)
- One (1) F418/F424 rail set (MCP-290-41803-0N)

Note: For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: <http://www.supermicro.com/support/manuals/>
- Product drivers and utilities: <ftp://ftp.supermicro.com>
- Product safety information:
http://super-dev/about/policies/safety_information.cfm
- If you have any questions, please contact our support team at:
support@supermicro.com

1-2 Serverboard Features

At the heart of the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ lies the X9DRFF-iG+/iTG+/7G+/7TG+, a dual processor serverboard based on the Intel® C602 chipset. Below are the main features of the serverboard. (See Figure 1-1 for a block diagram of the chipset.)

Processors

The X9DRFF-iG+/iTG+/7G+/7TG+ supports single or dual Intel® E5-2600 series processors in Socket R LGA 2011 sockets. Please refer to the serverboard description pages on our web site for a complete listing of supported processors (www.supermicro.com).

Memory

The X9DRFF-iG+/iTG+/7G+/7TG+ has sixteen (16) memory sockets that can support up to 512 GB of ECC registered RDIMMs or up to 128 GB of unbuffered ECC/non-ECC UDIMMs in DDR3-1600/1333/1066/800 MHz speed, 1 GB, 2 GB, 4 GB, 8 GB, 16 GB or 32 GB size, and .at 1.35 or 1.5 voltages. Please refer to Chapter 5 for installing memory.

Note: For the latest CPU/memory updates, please refer to our website at <http://www.supermicro.com/products/motherboard>.

Onboard SAS

An LSI 2308 SAS controller provides eight SAS2 ports. The SAS drives are connected to a backplane that provides power, bus termination and configuration settings. RAID 0, 1, and 10 are supported.

Note: The operating system you use must have RAID support to enable the hotswap capability and RAID function of the SAS drives.

Onboard Serial ATA

A SATA controller is integrated into the chipset to provide a six-port SATA subsystem. Two of the ports support SATA 3.0 (RAID 0 and 1) and four support SATA 2.0 (RAID 0, 1, 5 and 10). See Chapter 5 for details.

Note: The operating system you use must have RAID support to enable the hotswap capability and RAID function of the SATA drives.

PCI Expansion Slots

Each node in the the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ has 3x PCI-E 3.0 x16 (that support three double-width GPU/MIC expansion cards) and 2x PCI-E 3.0 x8 expansion slots. Two riser cards are provided for each node for use with these expansion slots.

I/O Ports

The color-coded I/O ports located at the front of each node in the server include a VGA (monitor) port, two USB 2.0 ports, two 1 Gb Ethernet ports (the X9DRFF-iTG+/X9DRFF-7TG+ serverboard's feature two 10 Gb Ethernet ports instead) and one dedicated IPMI LAN port.

Note: For IPMI Configuration Instructions, please refer to the Embedded IPMI Configuration User's Guide available @ <http://www.supernmicro.com/support/manuals/>.

Graphics Controller

The X9DRFF-iG+/iTG+/7G+/7TG+ features an integrated Matrox G200ew, 16 MB DDR2 graphics controller.

Nuvoton WPCM450 Controller

Note: The term "IPMI controller" and the term "BMC controller" can be used interchangeably in this section.

The Nuvoton WPCM450R Controller, a Baseboard Management Controller (BMC), supports 2D/VGA-compatible Graphic Cores with PCI interface, creating multi-media virtualization via Keyboard/Video/Mouse Redirection (KVMR). The WPCM450R Controller is ideal for remote system management.

The WPCM450R Controller interfaces with the host system via PCI connections to communicate with the graphics cores. It supports USB 2.0 and 1.1 for remote keyboard/mouse/virtual media emulation. It also provides LPC interface support to control Super IO functions. The WPCM450R Controller is connected to the network via an external Ethernet PHY module or shared NCSI connections.

The WPCM450R communicates with onboard components via six SMBus interfaces, PEI (Platform Environment Control Interface) buses, and General Purpose I/O ports.

WPCM450R DDR2 Memory Interface

The WPCM450R supports a 16-bit DDR2 memory module with a speed of up to 220 MHz. For best signal integrity, the WPCM450R provides point-to-point connection.

WPCM450R PCI System Interface

The WPCM450R provides 32-bit, 33 MHz 3.3V PCI interface, which is compliant with the PCI Local Bus Specification Rev. 2.3. The PCI system interface connects to the onboard PCI Bridge used by the graphics controller.

Other Features Supported by the WPCM BMC Controller

The WPCM450R supports the following features:

- IPMI 2.0
- Serial over LAN
- KVM over LAN
- LAN Alerting-SNMP Trap
- Event Log
- X-Bus parallel interface for I/O expansion
- Multiple ADC inputs, Analog and Digital Video outputs
- SPI Flash Host BIOS and firmware bootstrap program supported
- Reduced Media Independent Interface (RMII)
- OS (Operating System) Independency
- Provides remote Hardware Health Monitoring via IPMI. Key features
- Provides Network Management Security via remote access/console redirection.
- Supports the following Management tools: IPMIView, CLI (Command Line Interface)
- RMCP+ protocol supported

Note: For more information on IPMI configuration, please refer to the IPMI User's Guide posted on our website at <http://www.supermicro.com/support/manuals/>.

Power Supply

Please connect the power cable from the SMC-Proprietary Adaptor (BPN-ADP-F418L) to the motherboard in order to provide power to the system.

Super I/O

The Super I/O provides functions that comply with ACPI (Advanced Configuration and Power Interface), which includes support of legacy and ACPI power management through an SMI or SCI function pin. It also features auto power management to reduce power consumption.

1-3 Server Chassis Features

The following is a general outline of the main features of the F424AG server chassis.

System Power

The F424AG chassis model includes four high-efficiency 94%+ Platinum certified redundant 1620 Watt power supplies. In the unlikely event your power supply fails, replacement is simple and can be accomplished without tools.

SAS/SATA Subsystem

The F424AG supports up to two (2) hot-swap 3.5" SAS/SATA drives in trays for each node for a total of eight (8) drives. These drives are hot-swappable units and are connected to backplanes (that provides power and control).

Note: The operating system you use must have RAID support to enable the hot-swap capability of the drives. For more information, visit our Web site at: <http://www.supermicro.com>.

I/O Ports

The F424AG is an proprietary form factor chassis designed to be used in a 4U rackmount configuration. The F424AG chassis provides three low-profile add-on card slots, a VGA port, two USB 2.0 ports, one IPMI Ethernet port and two gigabit Ethernet ports per node.

Cooling System

The F424AG chassis accepts eight (8) 8-cm system fans powered from either the backpane or the serverboards. When one of the motherboard nodes is removed, another motherboard will continue to operate the fans.

Air Shrouds

The F424AG chassis requires mylar air shrouds for each node to direct the airflow where cooling is needed. The air shroud will differ for different motherboards. If using a motherboard which is not the default in the chassis, refer to the optional parts in the Appendix of this manual, or the Supermicro Web site at www.supermicro.com to purchase the proper air shroud.

Mounting Rails

The F424AG includes a set of rails, and can be placed in a rack for secure storage and use. To setup your rack, follow the step-by-step instructions included in this manual.

1-4 Advanced Power Management

Intel® Intelligent Power Node Manager (NM)

The Intel® Intelligent Power Node Manager (IPNM) provides your system with real-time thermal control and power management for maximum energy efficiency. Although IPNM Specification Version 1.5 is supported by the BMC (Baseboard Management Controller), your system must also have IPNM-compatible Manageability Engine (ME) firmware installed to use this feature.

Manageability Engine (ME)

The Manageability Engine, which is an ARC controller embedded in the IOH (I/O Hub), provides Server Platform Services (SPS) to your system. The services provided by SPS are different from those provided by the ME on client platforms.

1-5 Contacting Supermicro

Headquarters

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Email: support@supermicro.com.tw

Web Site: www.supermicro.com.tw

1-6 Fat Twin: System Notes

As a FatTwin configuration, the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ is a unique server system. With four system boards incorporated into a single chassis acting as four separate nodes, there are several points you should keep in mind.

Nodes

Each of the four serverboards act as a separate node in the system. As independant nodes, each may be powered off and on without affecting the others. In addition, each node is a hot-swappable unit that may be removed from the rear of the chassis. The nodes are connected to the server backplane by means of an adapter card.

Note: A guide pin is located between the upper and lower nodes on the inner chassis wall. This guide pin also acts as a “stop” when a node is fully installed. If too much force is used when inserting a node this pin may break off. Take care to slowly slide a node in until you hear the “click” of the locking tab seating itself.

System Power

Four 1620 Watt power supplies are used to provide the power for all serverboards. Each serverboard however, can be shut down independently of the other with the power button on its own control panel.

SAS/SATA Backplane/Drives

As a system, the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ supports the use of eight (8) 3.5" Hot-swap SAS/SATA drives. Each of the four backplanes in the system works to apply system-based control for power and fan speed functions, yet at the same time logically connects a set of two (2) hot-swap SAS/SATA drives to each backplane/serverboard. Consequently, RAID setup is limited to a two drive scheme (RAID cannot be spread across all drives). See Chapter 6 for the logical hard drive and node configuration.

Notes

Chapter 2

Server Installation

2-1 Overview

This chapter provides a quick setup checklist to get your FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ up and running. Following these steps in the order given should enable you to have the system operational within a minimum amount of time. This quick setup assumes that your system has come to you with the processors and memory preinstalled. If your system is not already fully integrated with a serverboard, processors, system memory etc., please turn to the chapter or section noted in each step for details on installing specific components.

2-2 Unpacking the System

You should inspect the box the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ was shipped in and note if it was damaged in any way. If the server itself shows damage you should file a damage claim with the carrier who delivered it.

Decide on a suitable location for the rack unit that will hold the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+. It should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated. You will also need it placed near a grounded power outlet. Read the Rack and Server Precautions in the next section.

2-3 Preparing for Setup

The box the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ was shipped in should include two sets of rail assemblies, two rail mounting brackets and the mounting screws you will need to install the system into the rack. Follow the steps in the order given to complete the installation process in a minimum amount of time. Please read this section in its entirety before you begin the installation procedure outlined in the sections that follow.

2-4 Warnings and Precautions

Choosing a Setup Location

- Leave enough clearance in front of the rack to enable you to open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow for sufficient airflow and ease in servicing.
- This product is for installation only in a Restricted Access Location (dedicated equipment rooms, service closets and the like).
- This product is not suitable for use with visual display work place devices according to §2 of the the German Ordinance for Work with Visual Display Units.

Rack Precautions

- Ensure that the leveling jacks on the bottom of the rack are fully extended to the floor with the full weight of the rack resting on them.
- In single rack installation, stabilizers should be attached to the rack. In multiple rack installations, the racks should be coupled together.
- Always make sure the rack is stable before extending a component from the rack.
- You should extend only one component at a time - extending two or more simultaneously may cause the rack to become unstable.

Server Precautions

- Review the electrical and general safety precautions in Chapter 4.
- Determine the placement of each component in the rack *before* you install the rails.
- Install the heaviest server components on the bottom of the rack first, and then work up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges, voltage spikes and to keep your system operating in case of a power failure.
- Allow any hot plug drives and power supply modules to cool before touching them.
- Always keep the rack's front door and all panels and components on the servers closed when not servicing to maintain proper cooling.

Rack Mounting Considerations



Warning! To prevent bodily injury when mounting or servicing this unit in a rack, you must take special precautions to ensure that the system remains stable. The following guidelines are provided to ensure your safety:

- This unit should be mounted at the bottom of the rack if it is the only unit in the rack.
- When mounting this unit in a partially filled rack, load the rack from the bottom to the top with the heaviest component at the bottom of the rack.
- If the rack is provided with stabilizing devices, install the stabilizers before mounting or servicing the unit in the rack.

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the ambient temperature of the room. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (T_{mra}).

Reduced Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (i.e. the use of power strips, etc.).

2-5 Rack Mounting Instructions

This section provides information on installing the chassis into a rack unit with the rails provided. There are a variety of rack units on the market, which may mean that the assembly procedure will differ slightly from the instructions provided. You should also refer to the installation instructions that came with the rack unit you are using.

Note: This rail will fit a rack between 26.5" and 36.4" deep. The SCF418 is not designed for installation into a Telco post-style rack unit.



Warning: Do not pick up the server with the front handles. They are designed to pull the system from a rack only.



Stability Hazard: The rack stabilizing mechanism must be in place, or the rack must be bolted to the floor before you slide the unit out for servicing. Failure to stabilize the rack can cause the rack to tip over.

Warning: When initially installing the server to a rack, test that the rail locking tabs engage to prevent the server from being overextended. Have a rack lift in place as a precaution in case the test fails.

Warning: In any instance of pulling the system from the rack, always use a rack lift and follow all associated safety precautions.

Identifying the Sections of the Rack Rails

The chassis package includes two rail assemblies in the rack mounting kit. Each assembly consists of two sections: A front section which secures to the front post of the rack and a rear section which adjusts in length and secures to the rear post of the rack. These assemblies are specifically designed for the left and right side of the chassis (see Figure 2-1).

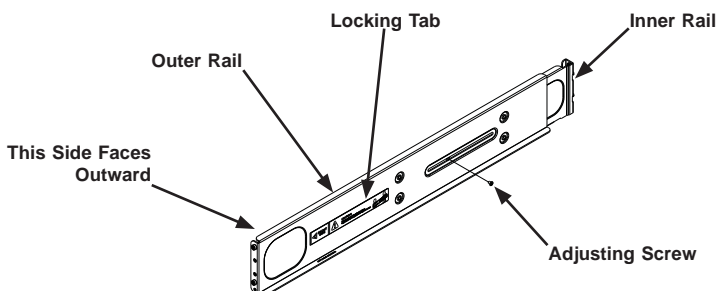
Adjusting the Rails

Each rail assembly has an adjusting screw. loosening this screw allows you to adjust the length of the rail to fit a variety of rack sizes.

Locking Tabs

Each inner rail has a locking tab. This tab locks the chassis into place when installed and pushed fully into the rack. These tabs also lock the chassis in place when fully extended from the rack. This prevents the server from coming completely out of the rack when the chassis is pulled out for servicing.

**Figure 2-1: Identifying the Outer Rail and Inner Rails
(Left Rail Assembly Shown)**

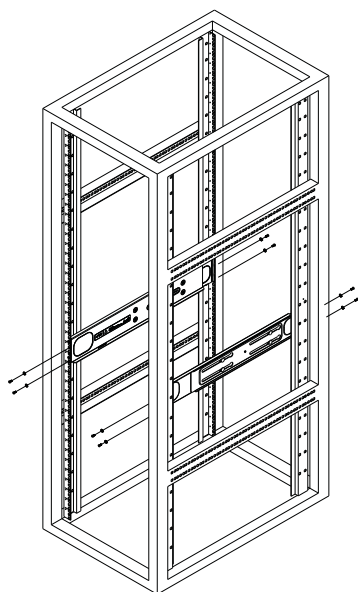


Installing the Rails on a Rack

Installing the Rails

1. Adjust the length of both rails as described on the previous page.
2. Align the front section of the outer rail with the slots on the front post of the rack. Secure the front of the outer rail to the rack with two screws.
3. Pull out the rear section of the outer rail, adjusting the length until it fits within the posts of the rack.
4. Align the rear section of the rail with the slots on the rear post of the rack. Secure the rear of the outer rail to the rear of the rack with two screws.
5. Repeat steps 1-4 for the remaining rail.

Figure 2-2: Attaching the Rails to a Rack

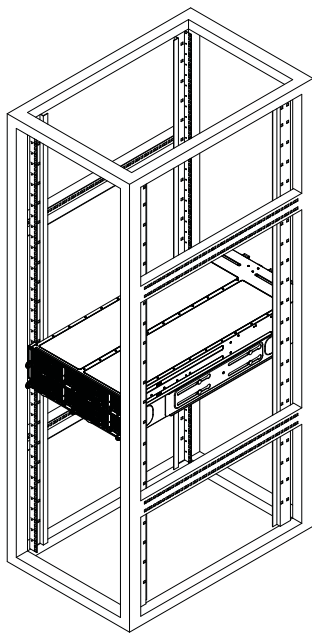


Chassis Installation

Installing the Chassis into a Rack

1. Confirm that the rails are correctly installed on the rack.
2. Align the bottom of the chassis with the bottom of the rails.
3. Insert the chassis into the rails, keeping the pressure even on both sides, pushing the chassis into the rack until it clicks into the locked position.
4. Secure the chassis handles to the front of the rack.

Figure 2-3: Installing into a Rack



Note: The figure above is for illustration purposes only. Always install servers to the bottom of the rack first.

2-6 Checking the Serverboard Setup

After you install the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ in the rack, you will need to open the unit to make sure the serverboard is properly installed and all the connections have been made.

Accessing the inside of the System

Before operating the server for the first time, it is important to remove the protective film covering the top of the chassis, in order to allow for proper ventilation and cooling.

Warning: Except for short periods of time, do NOT operate the server without the cover in place. The chassis cover must be in place to allow proper airflow and prevent overheating.

Checking the Components and Setup

1. You may have one or two processors already installed into the serverboard. Each processor needs its own heat sink. See Chapter 5 for instructions on processor and heat sink installation.
2. Your FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ server system may have come with system memory already installed. Make sure all DIMMs are fully seated in their slots. For details on adding system memory, refer to Chapter 5.
3. If desired, you can install add-on cards to the system. See Chapter 5 for details on installing PCI add-on cards.
4. Make sure all power and data cables are properly connected and not blocking the chassis airflow. Also make sure that no cables are positioned in front of the fans. See Chapter 5 for details on cable connections.

2-7 Checking the Drive Bay Setup

Next, you should check to make sure the peripheral drives and the SATA drives have been properly installed and all connections have been made.

Checking the Drives

1. All drives are accessible from the front of the server. A hard drive can be installed and removed from the front of the chassis without removing the top chassis cover.
2. Depending upon your system's configuration, your system may have one or more drives already installed. If you need to install hard drives, please refer to Chapter 6.

Checking the Airflow

1. Make sure there are no objects to obstruct airflow in and out of the server. In addition, if you are using a front bezel, make sure the bezel's filter is replaced periodically.
2. Do not operate the server without drives or drive trays in the drive bays. Use only recommended server parts.
3. Make sure that no wires or foreign objects obstruct air flow through the chassis. Pull all excess cabling out of the airflow path or use shorter cables. The control panel LEDs inform you of the system status. See "Chapter 3 System Interface" for details on the LEDs and the control panel buttons.

Providing Power

1. Plug the power cord(s) from the power supply unit(s) into a high-quality power strip that offers protection from electrical noise and power surges. It is recommended that you use an uninterruptible power supply (UPS).
2. Depress the power on button on the front of the chassis.

Notes

Chapter 3

System Interface

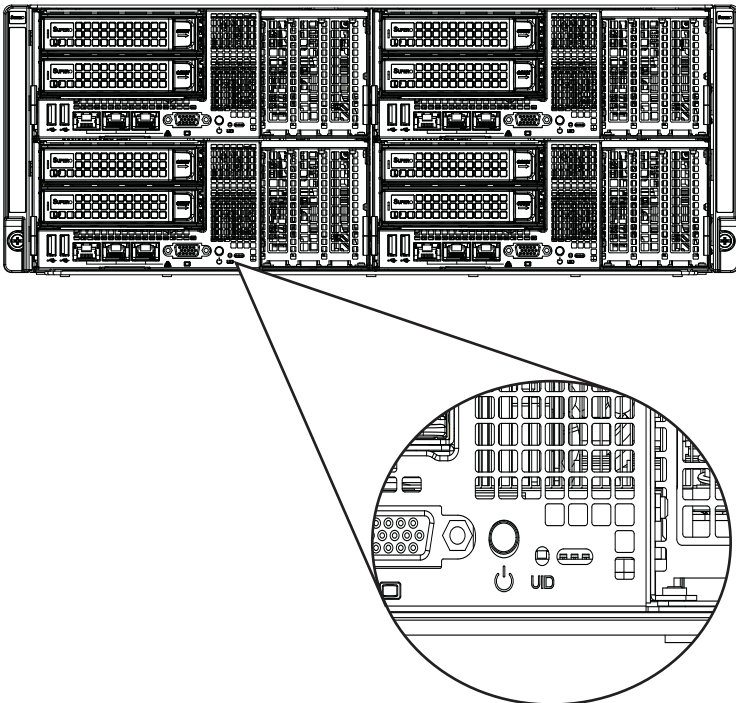
3-1 Overview

There are several buttons and LEDs are located on each of the motherboard nodes and on the drive carriers to keep you constantly informed of the overall status of the system.

This chapter explains the meanings of all LED indicators and the appropriate response you may need to take.

3-2 SCF424 Rear I/O Control Panel

Figure 3-1: F424AG Front I/O Control Panel



Control Panel Buttons



- **Power:** The main power button on each of the four control panels is used to apply or remove power from the power supply to each of the four systems in the chassis. Turning off system power with this button removes the main power, but keeps standby power supplied to the system. Therefore, you must unplug system before servicing. The power button has a built-in LED which will turn green when the power is on



- **UID:** When used with a UID compatible motherboard, the UID button is used to turn on or off the blue light function of the LED. This is built into the front side of the UID button and at the rear end of each motherboard node, for those motherboards which support it. Once the blue light is activated, the unit can be easily located in very large racks and server banks.

3-3 Drive Carrier LEDs

The F424AG chassis supports hot-swappable 3.5" SAS/SATA drives include the following LED indicators.

SAS/SATA Drives

Each SAS/SATA drive carrier has two LEDs.

- Blue: Each Serial ATA drive carrier has a blue LED. When illuminated, this blue LED (on the front of the SATA drive carrier) indicates drive activity. A connection to the SATA backplane enables this LED to blink on and off when that particular drive is being accessed.
- Red: The red LED to indicate an SAS/SATA drive failure. If one of the SAS/SATA drives fail, you should be notified by your system management software.

SCSI Drives

This chassis does not support SCSI drives.

Notes

Chapter 4

Standardized Warning Statements for AC Systems

4-1 About Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this appendix in its entirety before installing or configuring components in the Supermicro chassis.

These warnings may also be found on our web site at http://www.supermicro.com/about/policies/safety_information.cfm.

Warning Definition



Warning!

This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危險。

您正處於可能受到嚴重傷害的工作環境中。在您使用設備開始工作之前，必須充分意識到觸電的危險，並熟練掌握防止事故發生的標準工作程序。請根據每項警告結尾的聲明號碼找到此設備的安全性警告說明的翻譯文本。

此警告符號代表危險。

您正處於可能身體可能會受損傷的工作環境中。在您使用任何設備之前，請注意觸電的危險，並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הזהרות אזהרה

הזהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים.

יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

تحذير! هذا الرمز يعني خطر انك في حالة يمكن أن تتسبب في اصابة جسدية .
قبل أن تعمل على أي معدات، كن على علم بالمخاطر الناجمة عن الدوائر
الكهربائية
وكن على دراية بالممارسات الوقائية لمنع وقوع أي حوادث
استخدم رقم البيان المنصوص في نهاية كل تحذير للعثور ترجمتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기 바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions



Warning!

Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前，请先阅读安装说明。

警告

將系統與電源連接前，請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقرأ إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker



Warning!

This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡(過電流)保護装置がある建物での設置を前提としています。
保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי
המכשיר המגן מפני הקצר החשמלי הוא לא יותר מ-250 V, 20 A

هذا المنتج يعتمد على معدات الحماية من الدوائر القصيرة التي تم تثبيتها في
المبنى

تأكد من أن تقييم الجهاز الوقائي ليس أكثر من: 20A, 250V

경고!

이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다. 보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw elektrische installatie. Controleer of het beveiligde apparaat niet groter gedimensioneerd is dan 220V, 20A.

Power Disconnection Warning



Warning!

The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components.

電源切斷の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシー内部にアクセスするには、

システムの電源はすべてのソースから切斷され、電源コードは電源モジュールから取り外す必要があります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前,必須將系統完全斷電,並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg.Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chasis pour installer ou enlever des composants de système.

אזהרה מפני ניתוק חשמלי**אזהרה !**

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק לפני גישה לחלק הפנימי של המארו לצורך התקנת או הסרת רכיבים.

يجب فصل النظام من جميع مصادر الطاقة وإزالة سلك الكهرباء من وحدة امداد الطاقة قبل الوصول إلى المناطق الداخلية للهيكल لتثبيت أو إزالة مكونات الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 새시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation



Warning!

Only trained and qualified personnel should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓且具資格人員才可安裝、更換與維修此設備。

Warnung

Das Installieren, Ersetzen oder Bedienen dieser Ausrüstung sollte nur geschultem, qualifiziertem Personal gestattet werden.

¡Advertencia!

Solamente el personal calificado debe instalar, reemplazar o utilizar este equipo.

Attention

Il est vivement recommandé de confier l'installation, le remplacement et la maintenance de ces équipements à des personnels qualifiés et expérimentés.

אזהרה!

צוות מוסמך בלבד רשאי להתקין, להחליף את הציוד או לתת שירות עבור הציוד.

يجب أن يسمح فقط للموظفين المؤهلين والمدربين لتثبيت واستبدال أو خدمة هذا الجهاز

경고!

훈련을 받고 공인된 기술자만이 이 장비의 설치, 교체 또는 서비스를 수행할 수 있습니다.

Waarschuwing

Deze apparatuur mag alleen worden geïnstalleerd, vervangen of hersteld door geschoold en gekwalificeerd personeel.

Restricted Area



Warning!

This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所，限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域，進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installée dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

אזהרה!

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת כלי אבטחה בלבד (מפתח, מנעול וכד').

تم تخصيص هذه الوحدة لت تركيبها في مناطق محظورة .
يمكن الوصول إلى منطقة محظورة فقط من خلال استخدام أداة خاصة،
قفل ومفتاح أو أي وسيلة أخرى للأمان

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling



Warning!

There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

電池更換不當會有爆炸危險。請只使用同類電池或製造商推薦的功能相當的電池更換原有電池。請按製造商的說明處理廢舊電池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

אזהרה!

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף את הסוללה בסוג התואם מחברת יצרן מומלצת.

סילוק הסוללות המושמשות יש לבצע לפי הוראות היצרן.

هناك خطر من انفجار في حالة استبدال البطارية بطريقة غير صحيحة فعليك استبدال البطارية فقط بنفس النوع أو ما يعادلها كما أوصت به الشركة المصنعة تخلص من البطاريات المستعملة وفقا لتعليمات الشركة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontplofingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies



Warning!

This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。

ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告

此部件连接的电源可能不止一个，必须将所有电源断开才能停止给该部件供电。

警告

此裝置連接的電源可能不只一個，必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein Strom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחידה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן את היחידה.

قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة.
يجب إزالة كافة الاتصالات لعزل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage



Warning!

Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。
修理する際にはご注意ください。

警告

当系统正在进行时，背板上有很危险的电压或能量，进行维修时务必小心。

警告

當系統正在進行時，背板上有危險的電壓或能量，進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה !

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך העבודה.

هناك خطر من التيار الكهربائي أو الطاقة الموجودة على اللوحة
عندما يكون النظام يعمل كن حذرا عند خدمة هذا الجهاز

경고!

시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생합니다. 서비스 작업 시 주의하십시오.

Waarschuwing

Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes**Warning!**

Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告

设备安装必须符合本地与本国电气法规。

警告

設備安裝必須符合本地與本國電氣法規。

Warnung

Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!

La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales. Attention

L'équipement doit être installé conformément aux normes électriques nationales et locales.

תאום חוקי החשמל הארצי

אזהרה!

התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمثل للقوانين المحلية والوطنية المتعلقة بالكهرباء

경고!

현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing

Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal



Warning!

Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

אזהרה !

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

عند التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقاً لجميع القوانين واللوائح الوطنية

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Hot Swap Fan Warning



Warning!

The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing.

ファン・ホットスワップの警告

シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告

当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

當您從機架移除風扇裝置，風扇可能仍在轉動。小心不要將手指、螺絲起子和其他物品太靠近風扇。

Warnung

Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Los ventiladores podran dar vuelta cuando usted quite el montaje del ventilador del chasis. Mantenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador

Attention

Il est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

אזהרה!

כאשר מסירים את חלקי המאוורר מהמארז, יתכן והמאווררים עדיין עובדים. יש להרחיק למרחק בטוח את האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

من الممكن أن المراوح لا تزال تدور عند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة.

경고!

새시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조립품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter



Warning!

When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the code) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定された接続ケーブル、電源コードとACアダプターを使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSEマークがコードに表記)をSupermicroが指定する製品以外に使用することを禁止しています。

警告

安装此产品时,请使用本身提供的或指定的连接线,电源线和电源适配器.使用其它线材或适配器可能会引起故障或火灾.除了Supermicro所指定的产品,电气用品和材料安全法律规定禁止使用未经UL或CSA认证的线材。(线材上会显示UL/CSA符号)。

警告

安裝此產品時,請使用本身提供的或指定的連接線,電源線和電源適配器.使用其它線材或適配器可能會引起故障或火災.除了Supermicro所指定的產品,電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

Warnung

Bei der Installation des Produkts, die zur Verfügung gestellten oder benannt Anschlusskabel, Stromkabel und Netzteile. Verwendung anderer Kabel und Adapter kann zu einer Fehlfunktion oder ein Brand entstehen. Elektrische Geräte und Material Safety Law verbietet die Verwendung von UL-oder CSA-zertifizierte Kabel, UL oder CSA auf der Code für alle anderen elektrischen Geräte als Produkte von Supermicro nur bezeichnet gezeigt haben.

¡Advertencia!

Al instalar el producto, utilice los cables de conexión previstos o designados, los cables y adaptadores de CA. La utilización de otros cables y adaptadores podría ocasionar un mal funcionamiento o un incendio. Aparatos Eléctricos y la Ley de Seguridad del Material prohíbe el uso de UL o CSA cables certificados que tienen UL o CSA se muestra en el código de otros dispositivos eléctricos que los productos designados por Supermicro solamente.

Attention

Lors de l'installation du produit, utilisez les bables de connection fournis ou désigné. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et de loi sur la sécurité Matériel interdit l'utilisation de UL ou CSA câbles certifiés qui ont UL ou CSA indiqué sur le code pour tous les autres appareils électriques que les produits désignés par Supermicro seulement.

חשמליים ומתאמי AC

אזהרה !

כאשר מתקינים את המוצר, יש להשתמש בכבלים, ספקים ומתאמים AC אשר נועדו וסופקו לשם כך. שימוש בכל כבל או מתאם אחר יכול לגרום לתקלה או קצר חשמלי. על פי חוקי שימוש במכשירי חשמל וחוקי בטיחות, קיים איסור להשתמש בכבלים המוסמכים ב- UL או ב- CSA (כשאר מופיע עליהם קוד של UL/CSA) עבור כל מוצר חשמלי אחר שלא צוין על ידי סופרמיקרו בלבד.

عند تركيب الجهاز يجب استخدام كابلات التوصيل، والكابلات الكهربائية ومحولات التيار المتردد

التي . أن استخدام أي كابلات ومحولات أخرى يتسبب في حدوث عطل أو حريق. تم توفيرها لك مع المنتج

الأجهزة الكهربائية ومواد قانون السلامة يحظر استخدام الكابلات CSA أو UL معتمدة من قبل

لأي أجهزة كهربائية أخرى غير المنتجات المعينة من قبل Supermicro (التي تحمل علامة UL/CSA)

경고!

제품을 설치할 때에는 제공되거나 지정된 연결케이블과 전원케이블, AC어댑터를 사용해야 합니다. 그 밖의 다른 케이블들이나 어댑터들은 고장 또는 화재의 원인이 될 수 있습니다. 전기용품안전법 (Electrical Appliance and Material Safety Law)은 슈퍼마이크로에서 지정한 제품들 외에는 그 밖의 다른 전기 장치들을 위한 UL또는 CSA에서 인증한 케이블(전선 위에 UL/CSA가 표시)들의 사용을 금지합니다.

Waarschuwing

Bij het installeren van het product, gebruik de meegeleverde of aangewezen kabels, stroomkabels en adapters. Het gebruik van andere kabels en adapters kan leiden tot een storing of een brand. Elektrisch apparaat en veiligheidsinformatiebladen wet verbiedt het gebruik van UL of CSA gecertificeerde kabels die UL of CSA die op de code voor andere elektrische apparaten dan de producten die door Supermicro alleen.

Chapter 5

Advanced Motherboard Setup

This chapter covers the steps required to install the X9DRFF-iG+/iTG+/7G+/7TG+ motherboard into the chassis, connect the data and power cables and install add-on cards. All motherboard jumpers and connections are also described. A layout and quick reference chart are included in this chapter for your reference. Remember to completely close the chassis when you have finished working with the motherboard to better cool and protect the system.

5-1 Handling the Motherboard

Electrostatic Discharge (ESD) can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully (see previous chapter). To prevent the motherboard from bending, keep one hand under the center of the board to support it when handling. The following measures are generally sufficient to protect your equipment from electric static discharge.

Precautions

- Use a grounded wrist strap designed to prevent Electrostatic Discharge (ESD).
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the motherboard, add-on cards and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the motherboard.

Unpacking

The motherboard is shipped in antistatic packaging to avoid electrical static discharge. When unpacking the board, make sure the person handling it is static protected.

5-2 Connecting Cables

The FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ server needs to have both power and data cables connected to the X9DRFF-iG+/iTG+/7G+/7TG+ serverboard.

Connecting Power Cables

Four (4) 40-cm and 45-cm 18AWG 8-pin male to two 4-pin male power cables (part number CBL-0460L-02) are used to power SATA drives connecting to the SATA backplane and the serverboard for SATA drive power.

Connecting Data Cables

The cables used to transfer data from the peripheral devices have been carefully routed in preconfigured systems to prevent them from blocking the flow of cooling air that moves through the system from front to back. If you need to disconnect any of these cables, you should take care to reroute them as they were originally after reconnecting them (make sure the red wires connect to the pin 1 locations). If you are configuring the system, keep the airflow in mind when routing the cables.

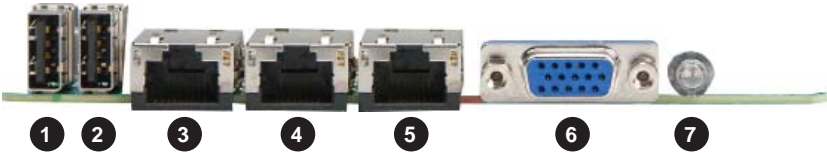
The FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ system uses the following data cables:

- Twenty-Four (24) 21-cm 30AWG SATA S-S cables (CBL-0473L)
- Eight (8) 27-cm 8-pin to 8-pin ribbon SGPIO cables with tube (CBL-0157L-02) to connect to the system for data.

5-3 Control Panel Connectors and I/O Ports

The rear I/O ports are color coded in conformance with the PC 99 specification. See Figure 5-1 below for the colors and locations of the various I/O ports.

Figure 5-1. Front I/O Ports



| Back Panel I/O Port Locations and Definitions | |
|---|---|
| 1. | Front Panel USB Port 1 |
| 2. | Front Panel USB Port 2 |
| 3. | IPMI LAN |
| 4. | Gigabit LAN 1 (for F627G3-FT+/F627G3-F73+) or 10-Gigabit LAN 1 (for F627G3-FTPT+/F627G3-F73PT+) |
| 5. | Gigabit LAN 2 (for F627G3-FT+/F627G3-F73+) or 10-Gigabit LAN 2 (for F627G3-FTPT+/F627G3-F73PT+) |
| 6. | VGA Port |
| 7. | Power Switch LED |

5-4 Processor and Heatsink Installation

Warning! When handling the processor package, avoid placing direct pressure on the label area.

Warning! If you buy a CPU separately, make sure that you use an Intel-certified multi-directional heatsink only.

Note: Always connect the power cord last, and always remove it before adding, removing or changing any hardware components. Make sure that you install the processor into the CPU socket before you install the CPU heatsink.

Note: Make sure to install the system board into the chassis before you install the CPU heatsink.

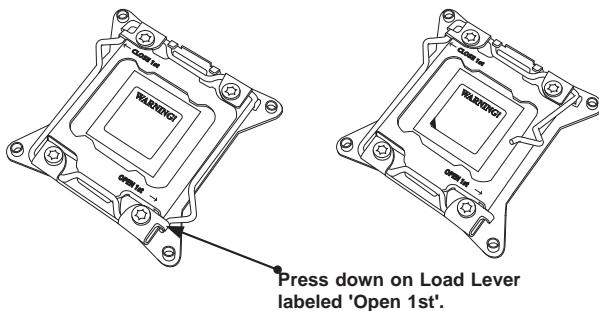
Note: When receiving a server board without a processor pre-installed, make sure that the plastic CPU socket cap is in place and none of the socket pins are bent; otherwise, contact your retailer immediately.

Note: Refer to the Supermicro website for updates on CPU support.

Note: When one CPU is installed, be sure to installed on CPU Socket 1 first.

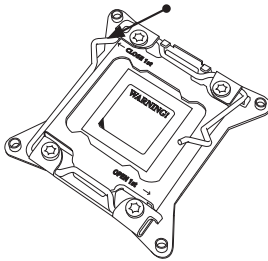
Installing the Socket R LGA 2011 Processor

1. There are two load levers on the LGA2011 socket. To open the socket cover, first press and release the load lever labeled 'Open 1st'.
2. Press the second load lever labeled 'Close 1st' to release the load plate that covers the CPU socket from its locking position.

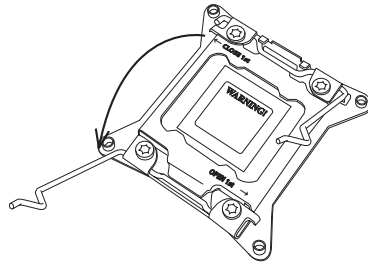


3. With the lever labeled 'Close 1st' fully retracted, gently push down on the 'Open 1st' lever to open the load plate. Lift the load plate to open it completely.

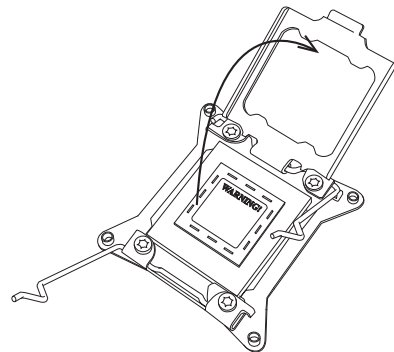
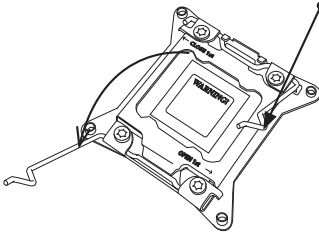
Press down on Load the Lever
labeled 'Close 1st'



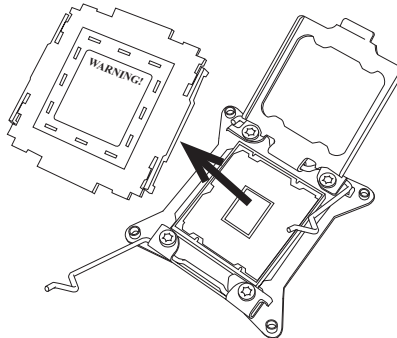
Pull lever away
from the socket



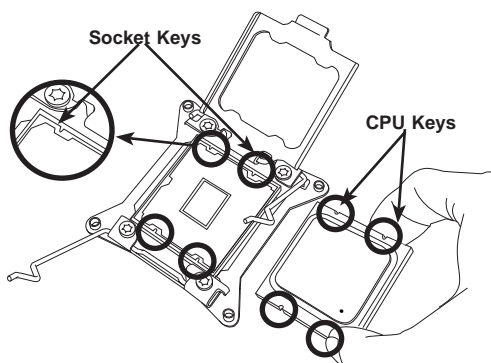
Gently push down to pop the
load plate open.



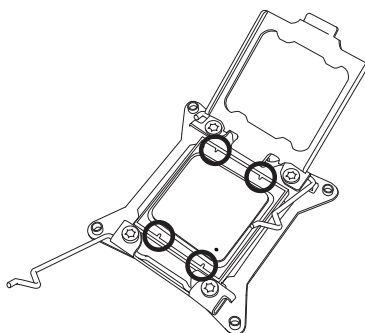
4. Using your thumb and the index finger, remove the 'WARNING' plastic cap from the socket.



5. Use your thumb and index finger to hold the CPU on its edges. Align the CPU keys, which are semi-circle cutouts, against the socket keys.

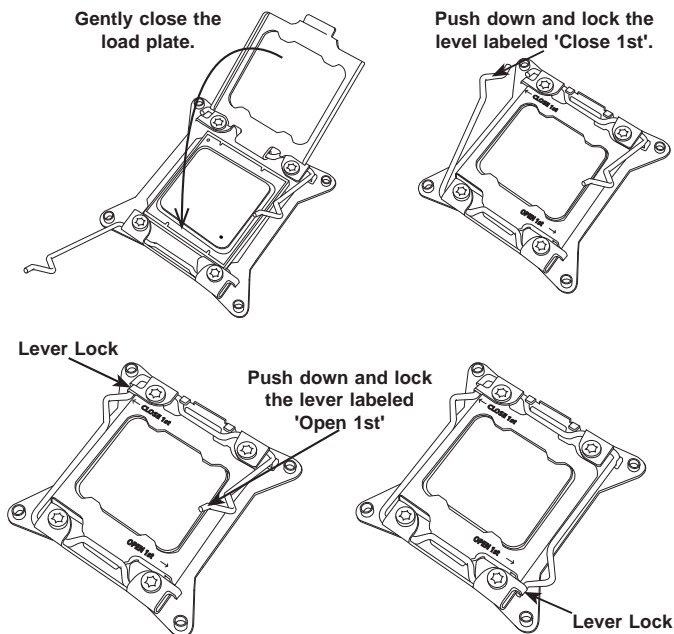


6. Once they are aligned, carefully lower the CPU straight down into the socket. (Do not drop the CPU on the socket. Do not move the CPU horizontally or vertically. Do not rub the CPU against the surface or against any pins of the socket to avoid damaging the CPU or the socket.)



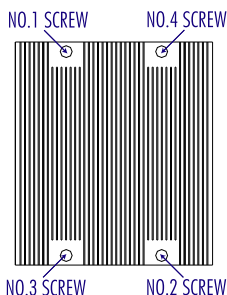
Caution: You can only install the CPU inside the socket in one direction. Make sure that it is properly inserted into the CPU socket before closing the load plate. If it doesn't close properly, do not force it as it may damage your CPU. Instead, open the load plate again and double-check that the CPU is aligned properly.

7. With the CPU inside the socket, inspect the four corners of the CPU to make sure that the CPU is properly installed.
8. Close the load plate with the CPU inside the socket. Lock the lever labeled 'Close 1st' first, then lock the lever labeled 'Open 1st' second. Use your thumb to gently push the load levers down to the lever locks.
9. Repeat steps to install a CPU to CPU Socket #2 if needed.



Installing a CPU Heatsink

1. Place the heatsink on top of the CPU so that the four mounting holes are aligned with those on the retention mechanism.
2. Screw in two diagonal screws (i.e. the #1 and the #2 screws) until just snug (do not over-tighten the screws, which may damage the CPU.)
3. Finish the installation by fully tightening all four screws.



Removing the Heatsink

1. Unplug the power cord from the power supply.
2. Unscrew and remove the heatsink screws in the sequence shown in the picture below.
3. Hold the heatsink and gently wiggle it to loosen it from the CPU. (Do not use excessive force when doing this!)
4. Once the heatsink is loosened, remove it from the CPU.
5. Clean the surface of the CPU and the heatsink to get rid of the old thermal grease. Reapply the proper amount of thermal grease before you re-install the heatsink.

Warning: We do not recommend removing the CPU or the heatsink. If you do need to remove the heatsink, please follow the instructions below to prevent damage to the CPU or other components.

5-5 Installing Memory

Caution: exercise extreme care when installing or removing DIMM modules to prevent any possible damage.

Installing Memory

1. Insert the desired number of DIMMs into the memory slots, starting with P1-DIMM #1A. (For best performance, please use the memory modules of the same type and speed in the same bank.)
2. Push the release tabs outwards on both ends of the DIMM slot to unlock it.
3. Align the key of the DIMM module with the receptive point on the memory slot.
4. Align the notches on both ends of the module against the receptive points on the ends of the slot.
5. Use two thumbs together to press the notches on both ends of the module straight down into the slot until the module snaps into place.
6. Press the release tabs to the locking positions to secure the DIMM module into the slot.

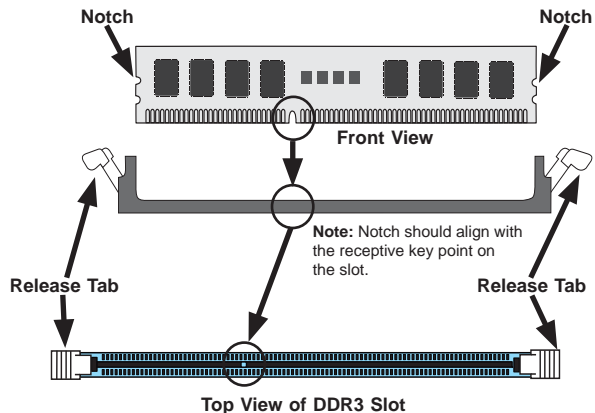
Reverse the steps above to remove the DIMM modules from the motherboard.

Note: 1 GB, 2 GB, 4 GB, 8 GB, 16 GB or 32 GB size memory modules are supported. It is highly recommended that you remove the power cord from the system before installing or changing memory modules. Please refer to our web site for memory that has been tested on the X9DRFF-iG+/iTG+/7G+/7TG+ serverboard.

Figure 5-2. Installing DIMM into Slot

To Install: Insert module vertically and press down until it snaps into place. Pay attention to the alignment notch at the bottom.

To Remove: Use your thumbs to gently push the release tabs near both ends of the module. This should release it from the slot.



Removing Memory Modules

Press both notches on the ends of the DIMM module to unlock it. Once the DIMM module is loosened, remove it from the memory slot.

Memory Support

The X9DRFF-iG+/iTG+/7G+/7TG+ motherboard supports up to 512 GB of 240-pin Registered (RDIMM)/Load Reduced (LRDIMM) ECC or up to 128 GB of Unbuffered (UDIMM) ECC/Non-ECC DDR3-1600/1333/1066/800 MHz speed 4-channel memory in sixteen (16) DIMM slots.

Note: For the latest CPU/memory updates, please refer to our website at <http://www.supermicro.com/products/motherboard>.

| Processors and their Corresponding Memory Modules | | | | | | | | |
|---|----------------------------|-----------|-----------|-----------|-----------|------------|-----------|-----------|
| CPU# | Corresponding DIMM Modules | | | | | | | |
| CPU 1 | P1-DIMMA1 | P1-DIMMB1 | P1-DIMMC1 | P1-DIMMD1 | P1-DIMMA2 | P1-DIMMB2 | P1-DIMMC2 | P1-DIMMD2 |
| CPU2 | P2-DIMME1 | P2-DIMMF1 | P2-DIMMG1 | P2-DIMMH1 | P2-DIMME2 | P2-DIMM F2 | P2-DIMMG2 | P2-DIMMH2 |

| Processor and Memory Module Population for Optimal Performance | |
|--|---|
| Number of CPUs+DIMMs | CPU and Memory Population Configuration Table (For memory to work properly, please follow the tables below.) |
| 1 CPU & 2 DIMMs | CPU1 P1-DIMMA1/P1-DIMMB1 |
| 1 CPU & 4 DIMMs | CPU1 P1-DIMMA1/P1-DIMMB1, P1-DIMMC1/P1-DIMMD1 |
| 1 CPU & 5~8 DIMMs | CPU1 P1-DIMMA1/P1-DIMMB1, P1-DIMMC1/P1-DIMMD1 + Any memory pairs in P1-DIMMA2/ P1-DIMMB2/P1-DIMMC2/P1-DIMMD2 slots |
| 2 CPUs & 4 DIMMs | CPU1 + CPU2 P1-DIMMA1/P1-DIMMB1, P2-DIMME1/P2-DIMMF1 |
| 2 CPUs & 6 DIMMs | CPU1 + CPU2 P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1, P2-DIMME1/P2-DIMMF1 |
| 2 CPUs & 8 DIMMs | CPU1 + CPU2 P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1, P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1 |
| 2 CPUs & 10~16 DIMMs | CPU1/CPU2 P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1, P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1 + Any memory pairs in P1, P2 DIMM slots |
| 2 CPUs & 16 DIMMs | CPU1/CPU2 P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1, P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1, P1-DIMMA2/P1-DIMMB2/P1-DIMMC2/P1-DIMMD2, P2-DIMME2/ P2-DIMMF2/P2-DIMMG2/P2-DIMMH2 |

Populating UDIMM (ECC/Non-ECC) Memory Modules

| Intel E5-2600(v2) Series Processor UDIMM Memory Support | | | | | | | | | | | |
|--|--|-----|-----|---|------------------------|------------|------------------|---------------------|------------------------|------------|------------------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (See the Note below) | | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | |
| | | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | |
| | | | | 1DPC | | 2DPC | | 1DPC | | 2DPC | |
| | | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5v |
| SRx8 Non-ECC | 1GB | 2GB | 4GB | NA | 1066, 1333, 1600, 1866 | NA | 1066, 1333, 1600 | N/A | 1066, 1333, 1600, 1866 | N/A | 1066, 1333, 1600 |
| DRx8 Non-ECC | 2GB | 4GB | 8GB | NA | 1066, 1333, 1600, 1866 | NA | 1066, 1333, 1600 | N/A | 1066, 1333, 1600, 1866 | N/A | 1066, 1333, 1600 |
| SRx16 Non-ECC | 512 MB | 1GB | 2GB | NA | 1066, 1333, 1600, 1866 | NA | 1066, 1333, 1600 | N/A | 1066, 1333, 1600, 1866 | N/A | 1066, 1333, 1600 |
| SRx8 ECC | 1GB | 2GB | 4GB | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 |
| DRx8 ECC | 2GB | 4GB | 8GB | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm . | | | | | | | | | | | |

Populating UDIMM (ECC/Non-ECC) Memory Modules

| Intel E5-2600 Series Processor UDIMM Memory Support | | | | | | | | | | | |
|---|--|-----|-----|---|------------|-------|------------|---------------------|-------------|------------|------------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (See the Note below) | | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | |
| | | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | |
| | | | | 1DPC | | 2DPC | | 1DPC | | 2DPC | |
| | | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5v |
| SRx8 Non-ECC | 1GB | 2GB | 4GB | NA | 1066, 1333 | NA | 1066, 1333 | N/A | 1066, 1333, | N/A | 1066, 1333 |
| DRx8 Non-ECC | 2GB | 4GB | 8GB | NA | 1066, 1333 | NA | 1066, 1333 | N/A | 1066, 1333, | N/A | 1066, 1333 |
| SRx16 Non-ECC | 512 MB | 1GB | 2GB | NA | 1066, 1333 | NA | 1066, 1333 | N/A | 1066, 1333 | N/A | 1066, 1333 |
| SRx8 ECC | 1GB | 2GB | 4GB | 1066, 1333 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066, 1333, | 1066, 1333 | 1066, 1333 |
| DRx8 ECC | 2GB | 4GB | 8GB | 1066, 1333 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066, 1333, | 1066, 1333 | 1066, 1333 |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm.. | | | | | | | | | | | |

Populating RDIMM (ECC) Memory Modules

| Intel E5-2600(v2) Series Processor RDIMM Memory Support | | | | | | | | | | | | | |
|---|--|----|----|---|------------------------|------------|------------------|---------------------|------------------------|------------|------------------|-------|-----------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (in GB) (See the Note Below) | | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | | | |
| | | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | | | |
| | | | | 1DPC | | 2DPC | | 1 DPC | | 2DPC | | 3DPC | |
| | | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V |
| SRx8 | 1 | 2 | 4 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 800 | 800, 1066 |
| DRx8 | 2 | 4 | 8 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 800 | 800, 1066 |
| SRx4 | 2 | 4 | 8 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 800 | 800, 1066 |
| DRx4 | 4 | 8 | 16 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600, 1866 | 1066, 1333 | 1066, 1333, 1600 | 800 | 800, 1066 |
| QRx4 | 8 | 16 | 32 | 800 | 800 1066 | 800 | 800 | 800 | 800, 1066 | 800 | 800 | N/A | N/A |
| QRx8 | 4 | 8 | 16 | 800 | 800 1066 | 800 | 800 | 800 | 800, 1066 | 800 | 800 | N/A | N/A |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm . | | | | | | | | | | | | | |

Populating RDIMM (ECC) Memory Modules

| Intel E5-2600 Series Processor RDIMM Memory Support | | | | | | | | | | | | | |
|---|--|----|----|---|------------------|------------|------------------|---------------------|------------------|------------|------------------|-------|-----------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (in GB) (See the Note Below) | | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | | | |
| | | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | | | |
| | | | | 1DPC | | 2DPC | | 1 DPC | | 2DPC | | 3DPC | |
| | | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5v |
| SRx8 | 1 | 2 | 4 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | N/A | 800, 1066 |
| DRx8 | 2 | 4 | 8 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | N/A | 800, 1066 |
| SRx4 | 2 | 4 | 8 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | N/A | 800, 1066 |
| DRx4 | 4 | 8 | 16 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | 1066, 1333 | 1066, 1333, 1600 | N/A | 800, 1066 |
| QRx4 | 8 | 16 | 32 | 800 | 1066 | 800 | 800 | 800 | 1066 | 800 | 800 | N/A | N/A |
| QRx8 | 4 | 8 | 16 | 800 | 1066 | 800 | 800 | 800 | 1066 | 800 | 800 | N/A | N/A |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm.. | | | | | | | | | | | | | |

Populating LRDIMM (ECC) Memory Modules

| Intel E5-2600(v2) Series Processor LRDIMM Memory Support | | | | | | | | | | | | |
|---|--|----|---|------------------------|------------------|------------------|---------------------|------------------------|------------------|------------------|-------|------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (in GB) (See the Note Below) | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | | | |
| | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | | | |
| | | | 1DPC | | 2DPC | | 1DPC | | 2DPC | | 3DPC | |
| | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V |
| QRx4 (DDP) | 16 | 32 | 1066, 1333, 1600 | 1066, 1333, 1600, 1866 | 1066, 1333, 1600 | 1066, 1333, 1600 | 1066, 1333, 1600 | 1066, 1333, 1600, 1866 | 1066, 1333, 1600 | 1066, 1333, 1600 | 1066 | 1066 |
| 8Rx4 (QDP) | 32 | 64 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm . | | | | | | | | | | | | |

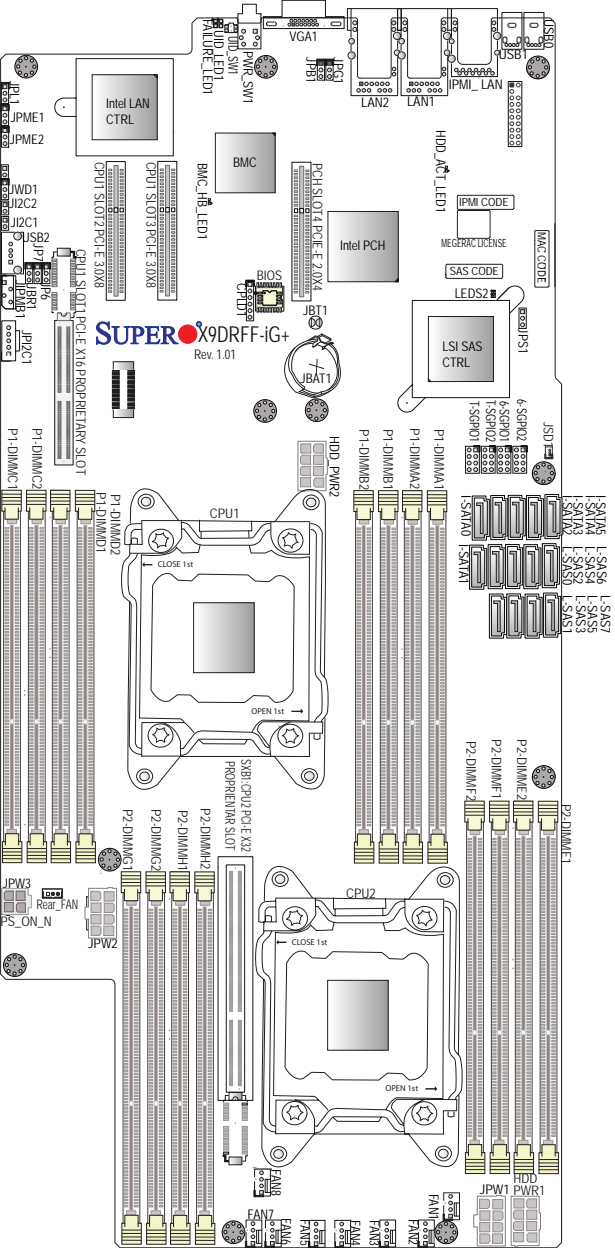
| Intel E5-2600 Series Processor LRDIMM Memory Support | | | | | | | | | | | | |
|---|--|----|---|------------|-------|------------|---------------------|------------|-------|------------|-------|------|
| Ranks Per DIMM & Data Width | Memory Capacity Per DIMM (in GB) (See the Note Below) | | Speed (MT/s) and Voltage Validated by Slot per Channel (SPC) and DIMM Per Channel (DPC) | | | | | | | | | |
| | | | 2 Slots Per Channel | | | | 3 Slots Per Channel | | | | | |
| | | | 1DPC | | 2DPC | | 1DPC | | 2DPC | | 3DPC | |
| | | | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V | 1.35V | 1.5V |
| QRx4 (DDP) | 16 | 32 | 1066 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066 |
| QRx8 (QDP) | 8 | 16 | 1066 | 1066, 1333 | 1066 | 1066, 1333 | 1066 | 1066 | 1066 | 1066 | 1066 | 1066 |
| Note: For detailed information on memory support and updates, please refer to the SMC Recommended Memory List posted on our website at http://www.supermicro.com/support/resources/mem.cfm . | | | | | | | | | | | | |

Other Important Notes and Restrictions

- For the memory modules to work properly, please install DIMM modules of the same type, same speed and same operating frequency on the motherboard. Mixing of RDIMMs, UDIMMs or LRDIMMs is not allowed. Do not install both ECC and Non-ECC memory modules on the same motherboard.
- Using DDR3 DIMMs with different operating frequencies is not allowed. All channels in a system will run at the lowest common frequency.

5-6 Serverboard Details

Figure 5-3. X9DRFF-iG+/iTG+/7G+/7TG+ Serverboard Layout



Notes:

1. For the latest CPU/Memory updates, please refer to our website at <http://www.supermicro.com/products/motherboard/> for details.
2. Use only the correct type of onboard CMOS battery as specified by the manufacturer. Do not install the onboard battery upside down to avoid possible explosion.
3. Both the X9DRFF-iTG+ and X9DRFF-7TG+ serverboards include 10-GB Ethernet ports.
4. Jumpers not indicated are for test purposes only.
5. All graphics shown in this manual were based upon the latest PCB Revision available at the time of publishing of the manual. The motherboard you've received may or may not look exactly the same as the graphics shown in this manual.

X9DRFF-7TG+/X9DRFF-7G+ Quick Reference

| Jumper | Description | Default Setting |
|---------------------------------------|------------------------|------------------------|
| JBT1 | Clear CMOS | See Section 5-9 |
| JP ² C1/JP ² C2 | SMB to PCI-E Slots | Open (Disabled) |
| JPB1 | BMC Enable | Pins 1-2 (Enabled) |
| JPG1 | VGA Enable | Pins 1-2 (Enabled) |
| JPL1 | LAN1/LAN2 Enable | Pins 1-2 (Enabled) |
| JPS1 | SAS Enable | Pins 1-2 (Enabled) |
| JWD1 | Watch Dog Timer Enable | Pins 1-2 (Reset) |

| Connector | Description |
|----------------------|--|
| FAN1-FAN8, Rear_FAN1 | CPU/System/Cooling Fan Headers |
| HDD_PWR1/HDD_PWR2 | 8-pin Power Supply Connectors for HDD Device Use |
| I-SATA 0/1 | SATA 3.0 Connectors 0/1 from Intel AHCI |
| I-SATA 2-5 | SATA 2.0 Connectors 2/3/4/5 from Intel AHCI |
| JIPMB1 | 4-pin External BMC I ² C Header (for IPMI Card) |
| JP ² C1 | Power Supply SMBbus I ² C Header |
| JPW1/JPW2 | 8-pin Power Connectors |
| JPW3 | 4-pin Power Connector |
| JSD1 | SATA Device Power Connector |
| JTPM1 | TPM (Trusted Platform Module)/Port 80 Connector |
| (J) USB2 | Internal USB 2 Port |
| L-SAS 0-7 | SAS Ports 0-7 from LSI 2308 SAS Controller |
| 6-SGPIO 1/2 | Serial Link General Purpose I/O Headers for SAS |
| T-SGPIO 1/2 | Serial Link General Purpose I/O Headers for SATA |
| PWR_SW1 | Power Switch (Button) |
| UID_SW1 | UID (Unit Identifier) Switch (SW1) |
| USB0/USB1 | Front Panel USB 0/ USB1 Ports |

| LED | Description | State: Status |
|--------------|--------------------|---|
| BMC_HB_LED1 | BMC Heartbeat LED | Blinking Green: BMC Normal |
| HDD_ACT LED1 | HDD Activity LED | Blinking Green: HDD Active |
| Failure_LED1 | Failure LED | Blinking On: Power Failure; Blinking: Fan Failure |
| LEDS2 | SAS Heartbeat LED | On (Green): SAS Normal |
| UID_LED1 | UID LED | On (Blue): Unit Identified |

5-7 Connector Definitions

ATX Power Connector

Two 8-pin power connectors (JPW1/JPW2) and a 4-pin power connector (JPW3) are used to provide power to the serverboard. In addition, two 8-pin power connectors (HDD_PWR1/2) are also located onboard to provide power from the serverboard to the HDD backplane for HDD device use. *Do not* use these connectors for other purposes. All power connectors mentioned above meet the SSI EPS 12V specification. See the tables on the right for pin definitions.

| 12V 8-pin PWR (JPW1/2) Pin Definitions | |
|---|------------|
| Pins | Definition |
| 1- 4 | Ground |
| 5-8 | +12V |

| 12V 4-pin PWR (JPW3) Pin Definitions | |
|---|------------|
| Pins | Definition |
| 1 | Ground |
| 2 | Ground |
| 3 | 5V SB |
| 4 | PS_ON_N |

| HDD PWR Pin Definitions | |
|----------------------------|------------|
| Pins | Definition |
| 1- 4 | Ground |
| 5-6 | +12V |
| 7-8 | +5V |

Universal Serial Bus (USB)

Two Universal Serial Bus ports (USB0, USB1), located on the I/O front panel, provide front-accessible USB support. In addition, a Type A USB connector (JUSB2), located next to the 4-pin JIPMB1 connector, also provides front-accessible USB support.

| Front Panel USB 0/1 & Type-A USB 2 Pin Definitions | |
|--|------------|
| Pin# | Definition |
| 1 | +5V |
| 2 | PO- |
| 3 | PO+ |
| 4 | Ground |
| 5 | NA |

Video Connection

A Video (VGA) port is located next to the LAN Port 2 on the I/O backplane. Refer to the layout below for the location.

Ethernet Ports

Two Ethernet ports (LAN1, LAN2) are located on the I/O front panel. These Ethernet ports support 10G LAN connections on the X9DRFF-iTG+ and X9DRFF-7TG+, or the 1G LAN connections on the X9DRFF-iG+ and X9DRFF-7G+.

In addition, an IPMI LAN port is also located on the front panel. All these ports accept RJ45 cables. Please refer to the LED Indicator Section for LAN LED information.



| LAN Ports (LAN1/2) Pin Definition | | | |
|--------------------------------------|------------|------|-----------------------------------|
| Pin# | Definition | Pin# | Definition |
| 1 | P2V5SB | 10 | SGND |
| 2 | TD0+ | 11 | Act LED |
| 3 | TD0- | 12 | P3V3SB |
| 4 | TD1+ | 13 | Link 100 LED (Yellow, +3V3SB) |
| 5 | TD1- | 14 | Link 1000 LED (Yellow, +3V3SB) |
| 6 | TD2+ | 15 | Ground |
| 7 | TD2- | 16 | Ground |
| 8 | TD3+ | 17 | Ground |
| 9 | TD3- | 18 | Ground |

NC indicates no connection.

Power Button/Unit Identifier Switch

A Unit Identifier switch (SW1) and a UID LED Indicator are located on the serverboard. In addition, a power button (PWR_SW1) is located next to the UID switch on the front panel. When you press the UID switch, the UID LED Indicator will be turned on. Press the UID switch again to turn off the UID LED. The UID Indicator provides easy identification of a system unit that may be in need of service.

Note: UID can also be triggered via IPMI on the serverboard. For more information on IPMI, please refer to the IPMI User's Guide posted on our website @ <http://www.supermicro.com>.

| UID Switch (SW1) Pin Definitions | |
|-------------------------------------|------------|
| Pin# | Definition |
| 1 | Ground |
| 2 | Ground |
| 3 | Button In |
| 4 | Ground |

| UID LED (UID_LED1) Status | | |
|------------------------------|------------|-----------------|
| Color/State | OS | Status |
| Blue: On | Windows OS | Unit Identified |
| Blue: Blinking | Linux OS | Unit Identified |

Fan Headers

This serverboard has eight 4-pin (Fan1~Fan8), and one 3-pin (Rear_Fan1) system/CPU/cooling fan headers on the serverboard. The 4-pin fan headers are backward compatible with traditional 3-pin fans. However, fan speed control is only available on 4-pin fans via IPMI firmware management. See the table on the right for pin definitions.

| Fan Header (Fan 1~8, Fan 9) Pin Definitions | |
|---|---|
| Pin# | Definition |
| 1 | Ground |
| 2 | +12V |
| 3 | Tachometer |
| 4 | PWR Modulation (Available for 4-pin fans only) |

IPMB

A System Management Bus header for IPMI 2.0 is located at JIPMB1. Connect the appropriate cable here to use the IPMB I²C connection on your system.

| IPMB Header Pin Definitions | |
|--------------------------------|---------------|
| Pin# | Definition |
| 1 | Data |
| 2 | Ground |
| 3 | Clock |
| 4 | No Connection |

SATA DOM Power Connector

A power connector for SATA DOM (Disk_On_Module) devices is located at JSD1. Connect an appropriate cable here to provide power support for your SATA DOM devices.

| DOM PWR (JSD1) Pin Definitions | |
|-----------------------------------|------------|
| Pin# | Definition |
| 1 | +5V |
| 2 | Ground |
| 3 | Ground |

T-SGPIO 1/2 & 6-SGPIO 1/2 Headers

Four SGPIO (Serial-Link General Purpose Input/Output) headers (T-SGPIO 1/2 & 6-SGPIO 1/2) are located on the motherboard. These headers support onboard Serial_Link interface connections.

Note: T-SGPIO 1/2 support onboard SATA connections. 6-SGPIO 1/2 support SAS interface on the X9DRFF-7G+ and X9DRFF-7TG+ serverboards only.

| T-SGPIO 1/2 S-SGPIO 1/2 Pin Definitions | | | |
|---|------------|-----|------------|
| Pin# | Definition | Pin | Definition |
| 1 | NC | 2 | NC |
| 3 | Ground | 4 | Data |
| 5 | Load | 6 | Ground |
| 7 | Clock | 8 | NC |

NC indicates no connection.

Power SMB (I²C) Connector

Power System Management Bus (I²C) Connector (JPI²C1) monitors power supply, fan and system temperatures. See the table on the right for pin definitions.

| PWR SMB (JPI ² C1) Pin Definitions | |
|--|------------|
| Pin# | Definition |
| 1 | Clock |
| 2 | Data |
| 3 | PWR Fail |
| 4 | Ground |
| 5 | +3.3V |

Power Switch

A power switch (PWR_SW1) is located next to the VGA port on the motherboard. Refer to the layout below for the location.

Unit Identification Switch/LED

A Unit Identifier switch (UID) and a UID LED indicator (UID_LED1) are located next to the power switch on the front panel. When the user pushes the UID switch, the UID LED (UID_LED1) will be turned on. Push the UID switch again to turn off the LED indicator. The UID switch provides easy identification of a system unit that may be in need of service. See the tables on the right for more information.

| UID Switch (UID) Pin Definitions | |
|-------------------------------------|------------|
| Pin# | Definition |
| 1 | Ground |
| 2 | Ground |
| 3 | Button In |
| 4 | Ground |

TPM Header/Port 80

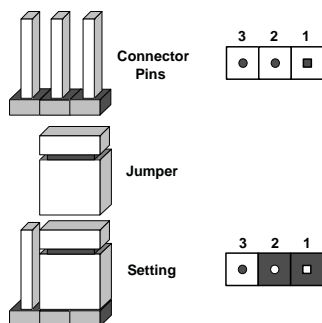
A Trusted Platform Module/Port 80 header, located at JTPM1, provides TPM support and Port 80 connection. Use this header to enhance system performance and data security. See the table on the right for pin definitions.

| TPM/Port 80 Header (JTPM1) Pin Definitions | | | |
|---|------------|------|-------------|
| Pin# | Definition | Pin# | Definition |
| 1 | LCLK | 2 | GND |
| 3 | LFRAME# | 4 | <(KEY)> |
| 5 | LRESET# | 6 | +5V (X) |
| 7 | LAD 3 | 8 | LAD 2 |
| 9 | +3.3V | 10 | LAD1 |
| 11 | LAD0 | 12 | GND |
| 13 | SMB_CLK4 | 14 | SMB_DAT4 |
| 15 | +3V_DUAL | 16 | SERIRQ |
| 17 | GND | 18 | CLKRUN# (X) |
| 19 | LPCPD# | 20 | LDRQ# (X) |

5-8 Jumper Settings

Explanation of Jumpers

To modify the operation of the motherboard, jumpers can be used to choose between optional settings. Jumpers create shorts between two pins to change the function of the connector. Pin 1 is identified with a square solder pad on the printed circuit board. See the diagram at right for an example of jumping pins 1 and 2. Refer to the motherboard layout page for jumper locations.



Note: On two-pin jumpers, "Closed" means the jumper is on and "Open" means the jumper is off the pins.



JBT1 contact pads

CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

1. First power down the system and unplug the power cord(s). It is also recommended that you remove the onboard battery from the serverboard.
2. With the power disconnected, short the CMOS pads with a metal object such as a small screwdriver.
3. Remove the screwdriver (or shorting device).
4. Reconnect the power cord(s) and power on the system.

Note 1. For an ATX power supply, you must completely shut down the system, remove the AC power cord, and then short JBT1 to clear CMOS.

Note 2. Be sure to remove the onboard CMOS Battery before you short JBT1 to clear CMOS.

Note 3. Clearing CMOS will also clear all passwords.

Note 4: Do not use the PW ON connector to clear CMOS.

GLAN Enable/Disable

JPL1 enables or disables LAN Port1/ LAN Port2 on the motherboard. See the table on the right for jumper settings. The default setting is Enabled.

| GLAN Enable (JPL1) Jumper Settings | |
|---------------------------------------|-------------------|
| Jumper Setting | Definition |
| 1-2 | Enabled (default) |
| 2-3 | Disabled |

Watch Dog Enable/Disable

Watch Dog (JWD1) is a system monitor that will reboot the system when a software application hangs. Close Pins 1-2 to reset the system if an application hangs. Close Pins 2-3 to generate a non-maskable interrupt signal for the application that hangs. See the table on the right for jumper settings. Watch Dog must also be enabled in the BIOS.

| Watch Dog (JWD1) Jumper Settings | |
|-------------------------------------|-----------------|
| Jumper Setting | Definition |
| Pins 1-2 | Reset (default) |
| Pins 2-3 | NMI |
| Open | Disabled |

VGA Enable

Jumper JPG1 allows the user to enable onboard VGA support. The default setting is on Pins 1-2 to enable VGA support. See the table on the right for jumper settings.

| VGA Enable (JPG1) Jumper Settings | |
|--------------------------------------|-------------------|
| Jumper Setting | Definition |
| 1-2 | Enabled (Default) |
| 2-3 | Disabled |

BMC Enable

Jumper JPB1 allows you to enable the embedded BMC (Baseboard Management) Controller to provide IPMI 2.0 support on the motherboard. See the table on the right for jumper settings.

| BMC Enable (JPB1) Jumper Settings | |
|--------------------------------------|----------------------|
| Jumper Setting | Definition |
| Pins 1-2 | BMC Enable (Default) |
| Pins 2-3 | Normal |

I²C Bus to PCI-Exp. Slots

Jumpers JI²C1 and JI²C2 allow you to connect the System Management Bus (I²C) to PCI-Express slots. The default setting is Open to disable the connection.

| I2C to PCI-Exp (JI2C1/JI2C2) Jumper Settings | |
|---|--------------------|
| Jumper Setting | Definition |
| 1-2 | Enabled |
| 2-3 | Disabled (Default) |

SAS Enable

Both the X9DRFF-7G+ and X9DRFF-7TG+ serverboards use Jumper JPS1 to enable onboard SAS support to enhance system performance. The default setting is enabled.

SAS Support Enable (JPS1) Jumper Settings

| Jumper Setting | Definition |
|----------------|-----------------------|
| Pins 1/2 | SAS Enabled (Default) |
| Pins 2/3 | SAS Disabled |

5-9 Onboard Indicators

GLAN LEDs

There are two LAN ports (LAN1/2) on the motherboard. Each Ethernet LAN port has two LEDs. The Yellow LED on the right indicates connection and activity. The Link LED on the left side may be green, amber or off to indicate the speed of the connection. See the tables at right for more information.



GLAN Activity Indicator (Right) LED Settings

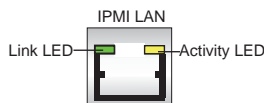
| Color | Status | Definition |
|--------|----------------|------------|
| Off | No Connections | |
| Yellow | Flashing | Active |

LAN Connection Speed Indicator (Left) LED Settings

| LED Color | Definition |
|-----------|------------|
| Off | 10 MHz |
| Green | 100 MHz |
| Amber | 1 GHz |

IPMI Dedicated LAN LEDs

In addition to LAN Ports 1/2, an IPMI Dedicated LAN is also located on the I/O Backplane. The amber LED on the right indicates connection and activity; while the green LED on the left indicates the speed of the connection. See the tables at right for more information.



IPMI LAN Link/Speed LED (Left) & Activity LED (Right)

| Color | Status | Definition |
|----------------|-------------------|---------------|
| Off | Off | No Connection |
| Green: Solid | Link/Speed (Left) | 100 Mb/s |
| Amber Blinking | Activity (Right) | Active |

HDD Activity LED

An HDD Activity LED is located at HDD_ACT_LED1 on the motherboard. When the HDD LED is blinking, an HDD device is active. See the table at right for more information.

| HDD Activity LED (HDD_ACT_LED1) Status | |
|---|-------------------------|
| Color or State | Definition |
| Green: Blinking | HDD: Active |
| Off | HDD Disabled, or Failed |

BMC Heartbeat LED

A BMC Heartbeat LED is located at BMC_HB_LED1 on the motherboard. When this LED indicator is blinking, BMC is normal. See the table at right for more information.

| BMC Heartbeat (BMC_HB_LED1) LED Status | |
|---|-------------------------|
| Color/State | Definition |
| Green: Blinking | BMC: Normal |
| Steady On | BMC Disabled, or Failed |

SAS Heartbeat LED

A SAS Heartbeat LED is located at SAS_HB_LED1 on the motherboard. When LEDS2 is blinking, SAS is working properly.

| SAS Heartbeat LED (SAS_HB_LED1) Status | |
|---|-------------------------|
| Color/State | Definition |
| Green: Blinking | SAS: Normal |
| Off or Red | SAS: Disabled or Failed |

Failure LED

A BMC Failure LED is located at Failure_LED1 on the motherboard. When this LED indicator is on, BMC is not working properly. See the table at right for more information.

| Failure LED (Failure_LED1) Status | |
|--|-------------|
| State | Definition |
| On | BMC: Failed |

UID LED

The Unit Identifier (UID) LED is located at UID_LED1 on the motherboard. When this LED is on, the unit that might be in need of service is identified. See the table at right for more information.

| Rear UID LED (UID_LED1) Status | |
|---|-----------------|
| Color/State | Definition |
| Blue: On | Unit Identified |

5-10 Serial ATA Connections

SATA/SAS Ports

Eight Serial_ATA ports are located on the motherboard. I-SATA Ports 0/1 support SATA 3.0. I-SATA Ports 2-5 and S-SATA 0 support SATA 2.0. In addition, eight SAS ports (L-SAS 0-7), supported by the LSI SAS 2208 Controller are also located on the X9DRFF-7G+/X9DRFF-7TG+. See the table on the right for pin definitions.

Note: For more information on SATA HostRAID configuration, please refer to the Intel SATA and LSI SAS HostRAID User's Guides posted on our Website @ <http://www.supermicro.com..>

| SATA/SAS (I-SATA0/1, I-SATA2-5, S-SATA0, L-SAS0-7) Pin Definitions | |
|---|------------|
| Pin# | Definition |
| 1 | Ground |
| 2 | TX_P |
| 3 | TX_N |
| 4 | Ground |
| 5 | RX_N |
| 6 | RX_P |
| 7 | Ground |

5-11 Installing Drivers

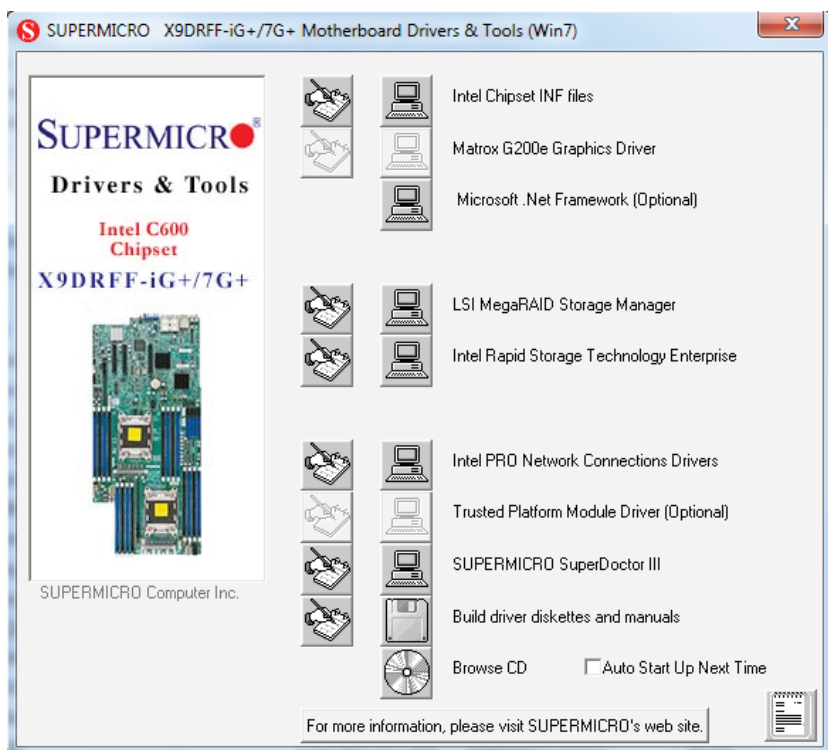
The Supermicro ftp site contains drivers and utilities for your system at <ftp://ftp.supermicro.com>. Some of these must be installed, such as the chipset driver.

After accessing the ftp site, go into the CDR_Images directory and locate the ISO file for your motherboard. Download this file to create a CD/DVD of the drivers and utilities it contains. (You may also use a utility to extract the ISO file if preferred.)

Another option is to go to the Supermicro Website at <http://www.supermicro.com/products/>. Find the product page for your motherboard here, where you may download individual drivers and utilities.

After creating a CD/DVD with the ISO files, insert the disk into the CD/DVD drive on your system and the display shown in Figure 5-4 should appear.

Figure 5-4. Driver/Tool Installation Display Screen



Note: Click the icons showing a hand writing on paper to view the readme files for each item. Click the computer icons to the right of these items to install each item (from top to the bottom) one at a time. **After installing each item, you must re-boot the system before moving on to the next item on the list.** The bottom icon with a CD on it allows you to view the entire contents.

SuperDoctor III

The SuperDoctor® III program is a web-based management tool that supports remote management capability. It includes Remote and Local Management tools. The local management is called SD III Client. The SuperDoctor III program allows you to monitor the environment and operations of your system. SuperDoctor III displays crucial system information such as CPU temperature, system voltages and fan status. See the figures below for examples of the SuperDoctor III interface.

Note: The default User Name and Password for SuperDoctor III is ADMIN / ADMIN.

Note: When SuperDoctor III is first installed, it adopts the temperature threshold settings that have been set in BIOS. Any subsequent changes to these thresholds must be made within SuperDoctor III, as the SuperDoctor III settings override the BIOS settings. To set the BIOS temperature threshold settings again, you would first need to uninstall SuperDoctor III.

Figure 5-5. Super Doctor III Interface Display Screen (Health Information)

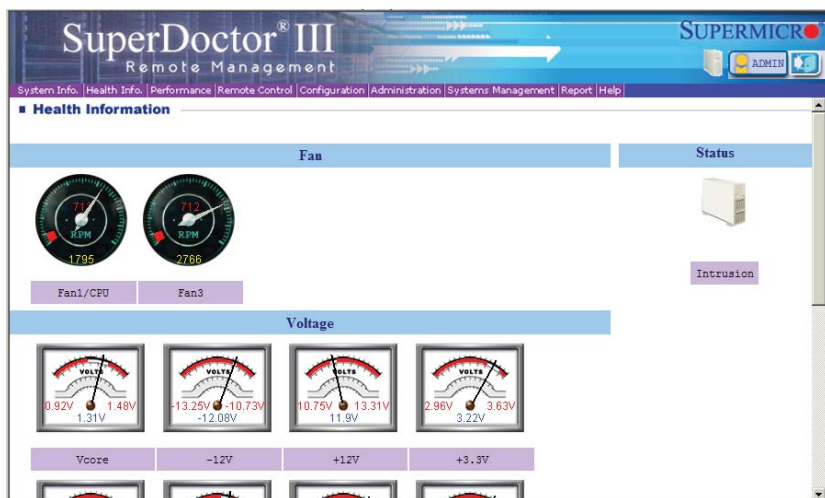
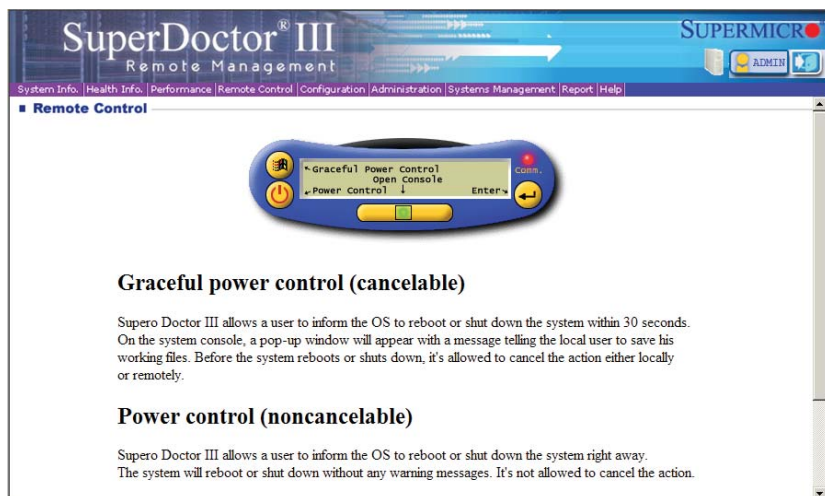


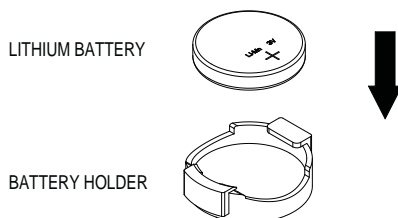
Figure 5-5. Supero Doctor III Interface Display Screen (Remote Control)

Note: The SuperDoctor III program and User's Manual can be downloaded from the Supermicro web site at <http://www.supermicro.com/products/accessories/software/SuperDoctorIII.cfm>. For Linux, we recommend that you use the SuperoDoctor II application instead.

5-12 Serverboard Battery

Caution: There is a danger of explosion if the onboard battery is installed upside down, which will reverse its polarities (see Figure 5-7). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer (CR2032). Dispose of used batteries according to the manufacturer's instructions.

Figure 5-7. Installing the Onboard Battery



Please handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

Notes

Chapter 6

Advanced Chassis Setup

This chapter covers the steps required to install components and perform maintenance on the F424AG-R1K62B chassis. For component installation, follow the steps in the order given to eliminate the most common problems

encountered. If some steps are unnecessary, skip ahead to the step that follows.

Tools Required: The only tool you will need to install components and perform maintenance is a Philips screwdriver.

6-1 Static-Sensitive Devices

Electrostatic discharge (ESD) can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully. The following measures are generally sufficient to protect your equipment from ESD damage.

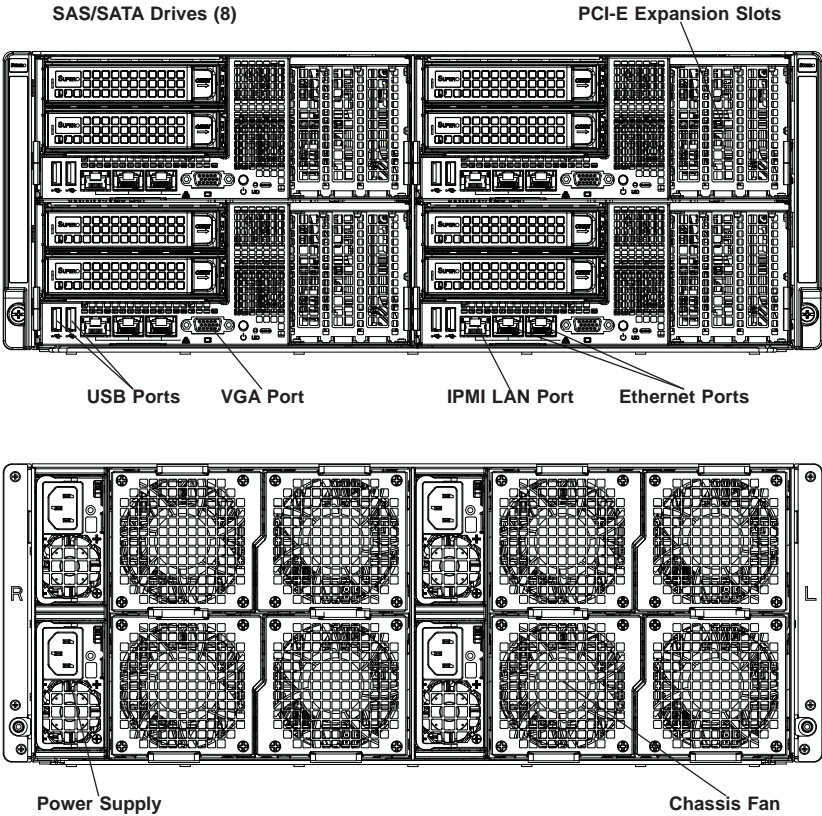
Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the serverboard, add-on cards and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the serverboard.

Unpacking

The serverboard is shipped in antistatic packaging to avoid static damage. When unpacking the board, make sure the person handling it is static protected.

Figure 6-1. Front and Rear Chassis Views



6-2 Control Panel

The control panel for each node is located on the front of the chassis. The LEDs inform you of system status.

See Chapter 3 for details on the LEDs and the control panel buttons.

6-3 Removing the Power Cord

Before performing any setup or maintenance on the chassis, use the following procedure to ensure that power has been removed from the system.

Removing the Power Cord

1. Use the operating system to power down the node, following the on-screen prompts.
2. After the system has completely shut-down, carefully grasp the head of the power cord and gently pull it out of the back of the power supply.
3. If your system has dual redundant power supplies, remove the cords from both power supplies.
4. Disconnect the cord from the power strip or wall outlet.

6-4 Removing Nodes from the Chassis

Each of the four individual motherboard nodes may be removed from the chassis. Note that any time a node is removed from the chassis, the hard drives located in the node will shut-down.

Removing a Motherboard Node

1. Power down the system and remove the power cords from the rear of the node as described in Section 6-3 above.
2. Grasp the node by the handles on either side of the front of the node.
3. Carefully pull the node forward and out of the chassis.

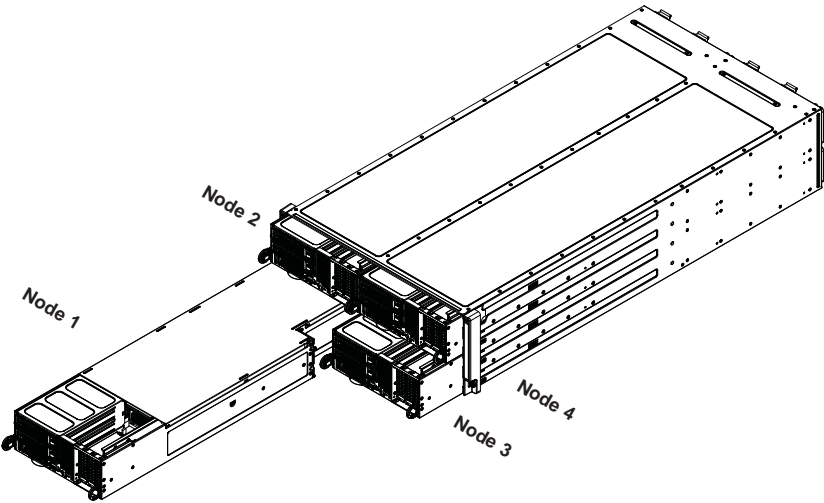
6-5 Installing and Removing Hard Drives

The F424AG chassis contains individual motherboards in separate 2U nodes. Each motherboard node controls the hard drives contained within that node. Note that if a motherboard node is pulled out of the chassis, the hard drives associated with that node will power down as well. Refer to the charts below and on the following pages for your specific chassis configuration. These instructions apply to hot-swappable hard drives in both 2.5" and 3.5" sizes.

Only enterprise level hard drives are recommended for use in Supermicro chassis.

| F424AG-R1K62B | |
|---|---|
| Node 2 Controls two 3.5" HDDs, B1-B2 | Node 4 Controls two 3.5" HDDs, D1-D2 |
| Node 1 Controls two 3.5" HDDs, A1-A2 | Node 3 Controls two 3.5" HDDs, C1-C2 |

Figure 6-2: Hard Drives and the Corresponding Motherboards



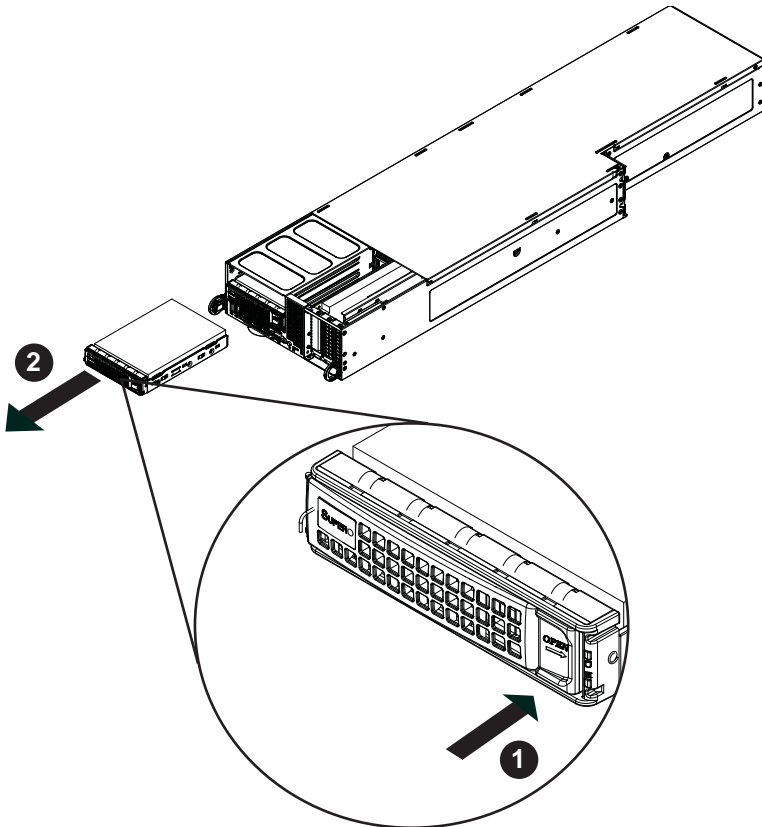
Removing Hard Drives from the Front of the Node

F424AG models are equipped with two (2) hot-swap 3.5" hard drives per node. These hard drives are hot-swappable and can be removed without powering down the server. The procedure to remove hard drives from the node is the same for both models.

Removing Hard Drive Carriers from the Chassis

1. Press the release button on the drive carrier. This extends the drive bay handle.
2. Use the handle to pull the drive carrier out of the chassis.

Figure 6-3: Removing a Hard Drive Carrier from the Front of the Node



Installing 3.5" Hard Drives into the Drive Carriers

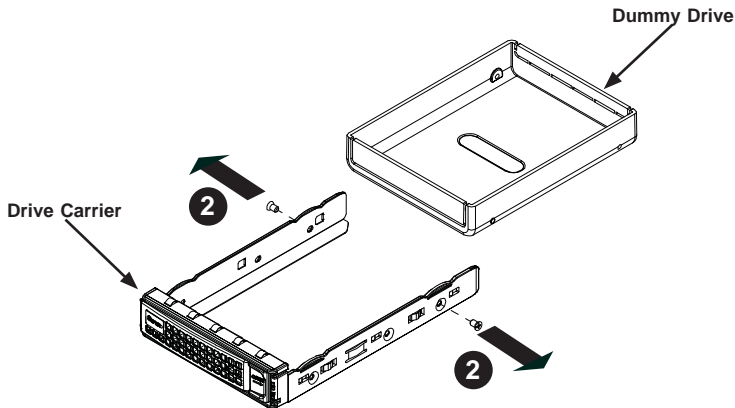
The hard drives are mounted in drive carriers to simplify their installation and removal from the chassis. These carriers also help promote proper airflow through the drive bays.

Removing the Dummy Drive from the Drive Carrier

1. Remove the hard drive carrier from the chassis as described in the previous section and lay the drive carrier on a flat surface.
2. Remove the screws securing the dummy drive to the drive carrier.
3. Lift the dummy drive from the drive carrier.

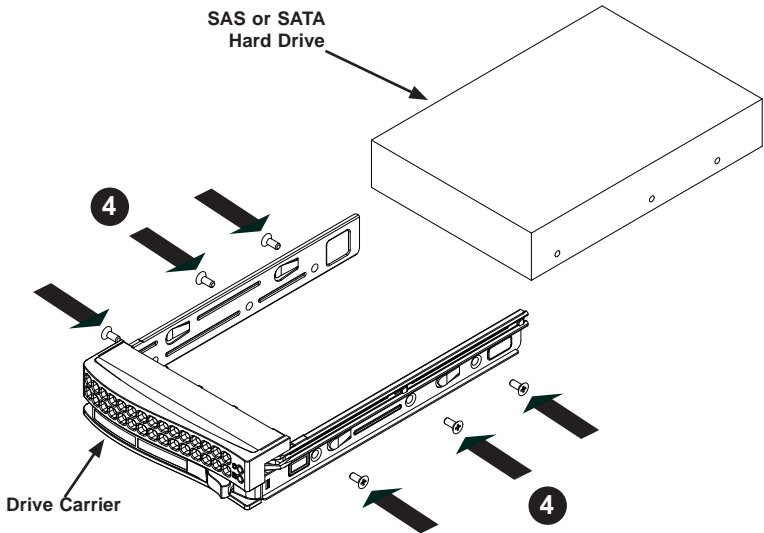
Warning: Except for short periods of time while swapping hard drives, do not operate the server with the hard drive bays empty.

Figure 6-4: Removing a Dummy Drive from the Drive Carrier



Installing a Hard Drive into the Drive Carrier

1. Place the hard drive carrier on a flat surface.
2. Insert the hard drive into the carrier with the printed circuit board side facing downward and so that the mounting holes in the drive align with those in the drive carrier.
3. Secure the hard drive to the carrier with the screws included with the hard drive.
4. Use the open handle of the drive carrier to insert the drive carrier into the open drive bay.
5. Secure the drive carrier into the drive bay by closing the drive carrier handle.

Figure 5-5: Installing a Hard Drive into the Drive Carrier

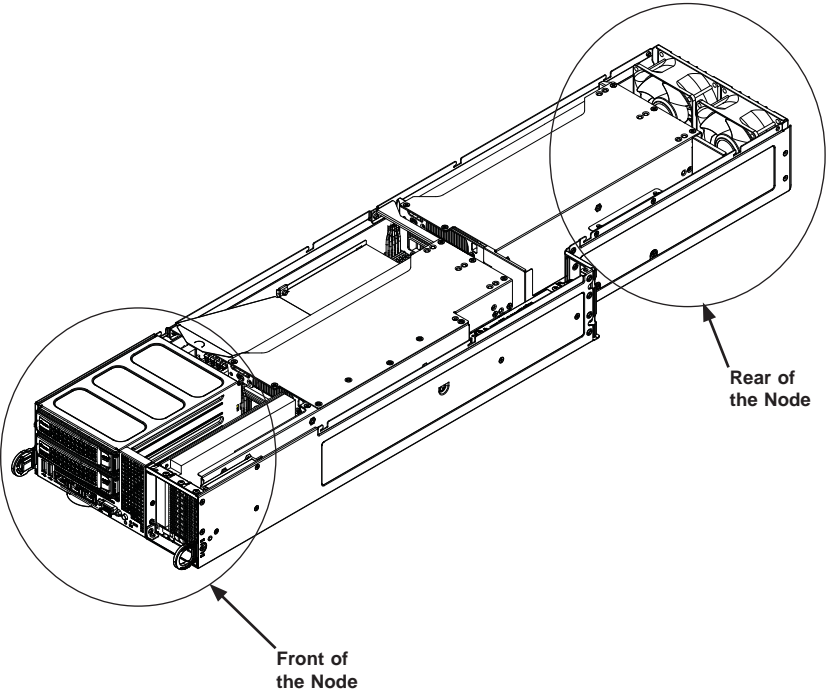
Caution: Enterprise level hard disk drives are recommended for use in Supermicro chassis and servers. For information on recommended HDDs, visit the Supermicro Web site at <http://www.supermicro.com/products/nfo/files/storage/SAS-CompList.pdf>

6-6 Node Configurations

Node configuration specifications are shown in the table below.

| F424AG-R1K62B | |
|--|-------------------------|
| Front of Node | Rear of Node |
| Two low-profile PCI-E slots Two 3.5" HDDs | Two optional fixed fans |

Figure 6-6: F424AG Node



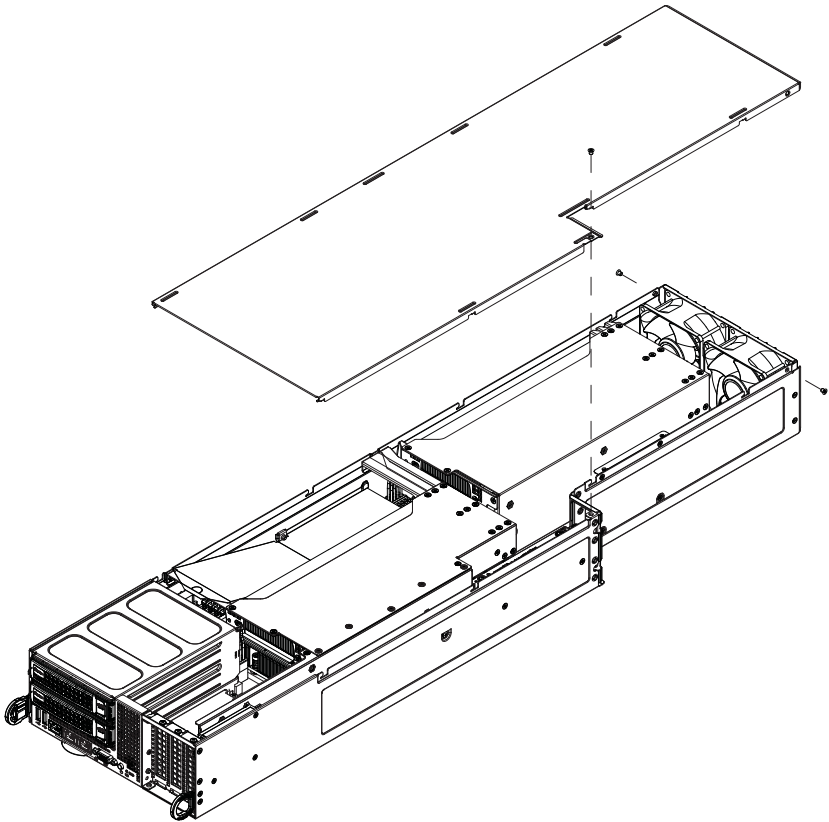
6-7 Removing the Node Cover

Each node has a removable cover which will permit access to the nodes components.

Removing the Node Cover

1. Power down the system and remove the power cord from the rear of the power supply as described in Section 6-3. Remove the node from the chassis as described in Section 6-4 and place the node on a flat, stable surface.
2. Remove the screws securing the cover to the node, as illustrated above.
3. Lift the cover up and off the node.

Figure 6-7: Removing the Node Cover



6-8 Removing and Installing the Backplane

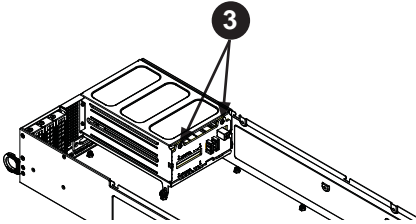
The F424AG chassis backplane is located behind the hard drives and in front of the front system fans in each motherboard node. Although backplane failure rarely occurs, in the event of a backplane failure, follow the instructions below.

Removing the Backplane

Removing the Backplane from the Node

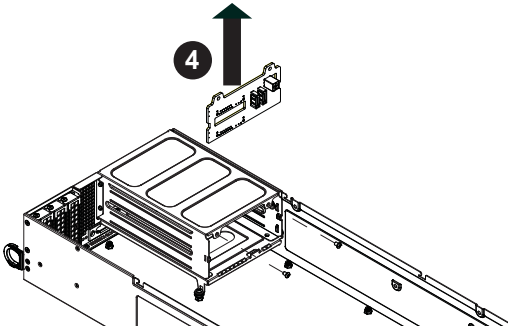
1. Remove the power cord from the rear of the node as described in Section 6-2. Remove the node from the chassis as described in Section 6-3. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Lift the mylar air shroud off the top of the motherboard and remove it from the node.
3. Remove the two screws securing the backplane to the node.

Figure 6-8: Removing the Screws from the Backplane



4. Lift the backplane up and out of the node.

Figure 6-9: Removing the Backplane from the Node

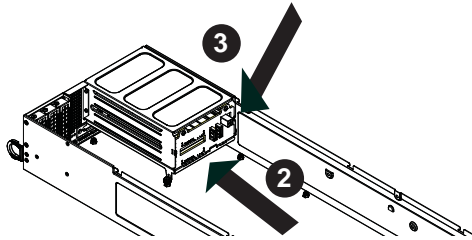


Installing the Backplane

Installing the Backplane into the Node

1. Ensure that all of the hard drive carriers have been removed from the bays in the front of the node (see 6-5 Installing and Removing Hard Drives).
2. Ease the backplane forward, against the front of the node.
3. Align the mounting holes in the backplane with the holes in the chassis. Replace the screws securing the backplane to the Node.

Figure 6-10: Installing the Backplane



4. Reconnect all cables and return the hard drive trays to their bays in the front of the motherboard node.
5. Return the air shroud to its position on the motherboard, reinstall the cover onto the node, plug the power cord into the back of the power supply and power up the system.

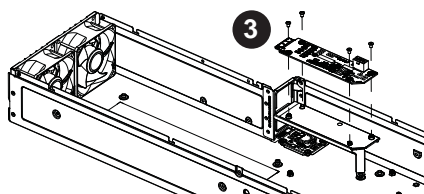
6-9 Power Distributor Board Replacement

Each of the motherboard nodes includes an upper and lower power distributor board. In the unlikely event of a failure of the power distributor board, replacement is simple and requires only a Phillips head screwdriver.

Changing the Power Distributor Board

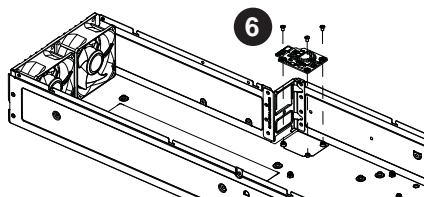
1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Remove the four screws securing the upper power distributor board to the support bracket.
3. Carefully lift the power distributor board up and out of the node. Set the screws aside for later use.

Figure 6-11: Removing the Upper Power Distributor Board



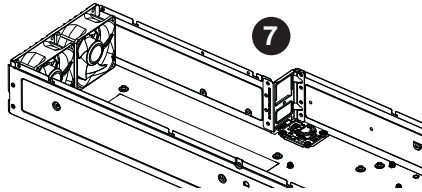
4. Remove the screw securing the bracket to the floor of the node and lift it out of the node.
5. Remove the screws securing the lower power distributor board to the floor of the node and set the screws aside for later use.
6. Lift the lower power distributor board up and out of the chassis.

Figure 6-12: Removing the Lower Power Distributor Board



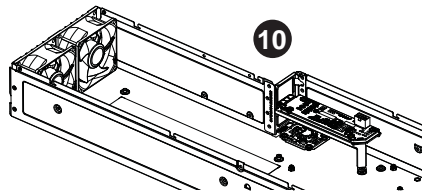
7. Install the replacement lower power distributor board into the same position on the floor of the motherboard node, aligning the mounting holes of the board with those in the node.

Figure 6-13: Installing the Lower Power Distributor Board



8. Secure the lower power distributor board with the two screws previously set aside. Do not exceed eight pounds of torque when tightening the screws.
9. Put the support bracket back into place in the node and secure it with the screw previously set aside.
10. Secure the upper power distributor board to the support bracket using the four screws previously set aside. Do not exceed eight pounds of torque when tightening the screws.

Figure 6-14: Installing the Upper Power Distributor Board



11. Replace the air shroud as described on page 5-20 and return the node to its bay in the chassis.
12. Reattach the power cord to the back of the power supply and power up the node.

6-10 Installing the Motherboard

Compatible Motherboards

For the most up-to-date information on compatible motherboards and other parts, visit the Supermicro Web site at www.supermicro.com.

Permanent and Optional Standoffs

Standoffs prevent short circuits by creating space between the motherboard and the floor of the node. The F424AG chassis includes permanent standoffs in locations used by most motherboards. These standoffs use the rounded Phillips head screws included in the F424AG accessories packaging.

Some motherboards require additional screws for heatsinks, general components and/or non-standard security. Optional standoffs are used for these motherboards.

To use an optional standoff, compare the mounting holes in the motherboard with those in the floor of the motherboard node. Then place a screw through the bottom the node and secure the screw with a hexagonal nut (rounded side up).

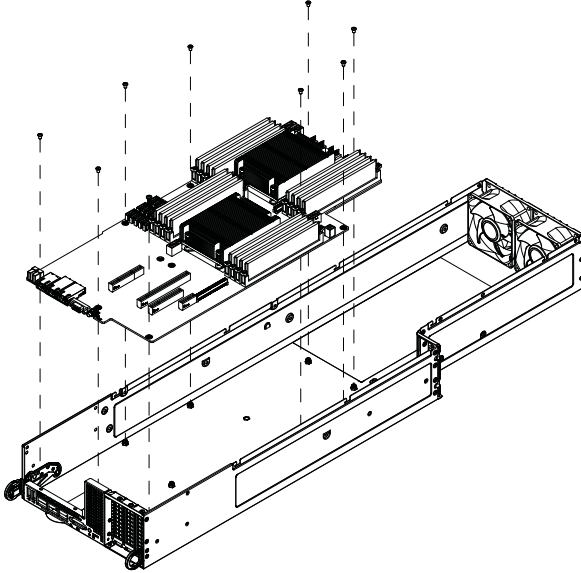
Depending upon the configuration of the motherboard being used, it is also possible that some of the optional standoffs which are pre-installed in the chassis, may need to be removed. Add or remove standoffs as needed.

Installing the Motherboard

1. Review the documentation that came with your motherboard. Become familiar with component placement, requirements, cautions, and cable connections.
2. Power down the system and remove the power cord from the rear of the power supply as described in Section 6-3. Remove the node from the chassis as described in Section 6-4 and place the node on a flat, stable surface. Remove the cover from the node as described in Section 6-7.
3. Compare the holes in the motherboard with those in the floor of the node, then add or remove standoffs as needed.
4. Secure the motherboard to the floor of the node tray using the rounded, Phillips head screws included for this purpose. Do not exceed eight pounds of torque when tightening down the motherboard.
5. Install the expansion card associated with the motherboard if the chassis is a hot-swappable version. Refer to the next section for instructions on installing the expansion card
6. Secure the CPU(s), heatsinks, and other components to the motherboard as described in the motherboard documentation.

7. Connect the cables between the motherboard, backplane, chassis, front panel, and power supply, as needed. The fans may be temporarily removed to allow access to the backplane ports.
8. Replace the expansion card bracket and secure the bracket with a screw.
9. Repeat steps 3 - 5 for the remaining nodes.

Figure 6-15: Installing the Motherboard in the Motherboard Node Tray

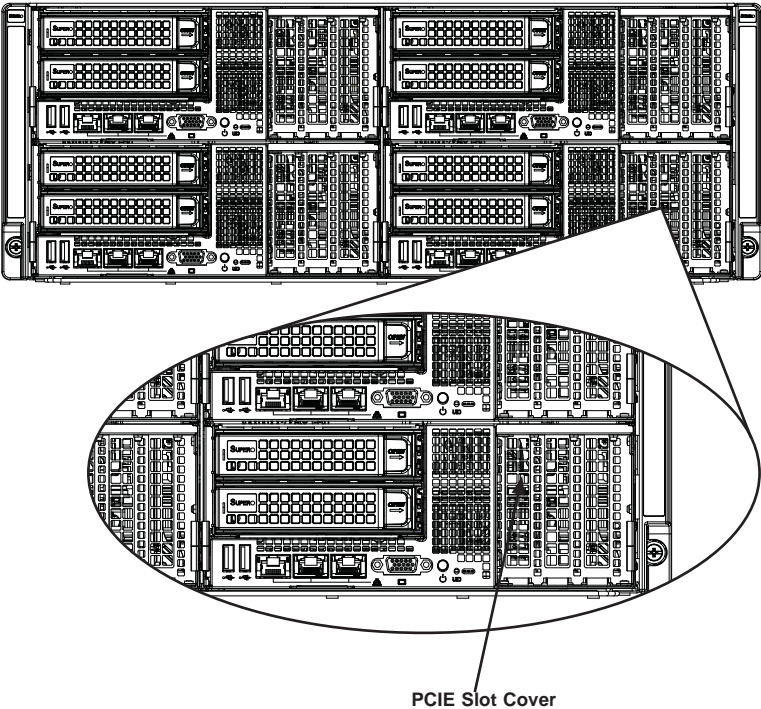


6-11 Installing Front and Rear Expansion Cards

PCIE Slot Setup

The nodes of some F424AG chassis models support expansion cards. To install low-profile expansion cards, follow the instructions on the following pages.

Figure 6-16: PCIE Slot Shield Configuration



F424AG PCIE Slot Configurations

The F424AG chassis supports up to two expansion cards in the PCIE slots of each node. Refer to the tables below to determine the PCIE slot configuration for your particular chassis.

| F424AG-R1K62B | |
|--|-------------------------|
| Front of Node | Rear of Node |
| Two low-profile expansion cards Two 3.5" HDDs | Two optional fixed fans |

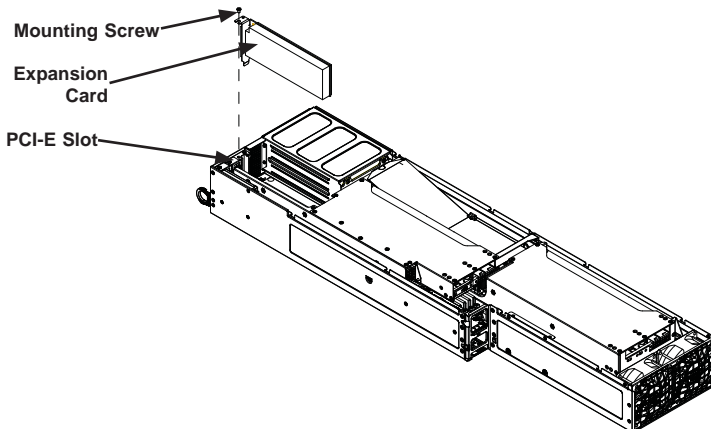
Installing a Low-Profile Expansion Card

Each motherboard node supports two low-profile expansion cards.

Installing an Expansion Card into a Node

1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Remove the mounting screw which secures the PCI-E slot cover in the PCI-E slot and set this aside for later use.
3. Remove the PCI-E slot cover by sliding it upward and out of the PCI-E slot.
4. Simultaneously slide the expansion card into the open PCI-E slot, while inserting the expansion card into the motherboard.
5. Secure the expansion card to the node using the screws that were previously set aside.
6. Replace the air shroud as described in the following section.
7. Place the cover on the node and secure it with the screws previously set aside.
8. Return the node to its bay in the chassis.

Figure 6-17: Installing the Expansion Card



6-12 Installing Internal GPUs

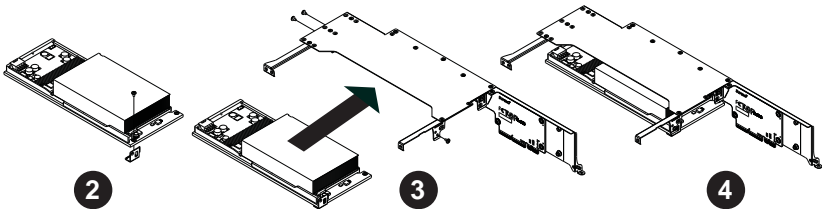
Each node supports one 10.5" internal front GPU and up to two 13" rear GPUs, with the option to reduce one 13" GPU to 10.5" to accommodate an optional rear system fan. There are a variety of internal GPUs supported by the F424AG chassis. For the most up-to-date list of compatible GPUs, visit the Supermicro web site at www.supermicro.com.

Installing Front 10.5" GPUs into the GPU Bracket

Installing a Front 10" AMD Whoodier GPU into a Bracket

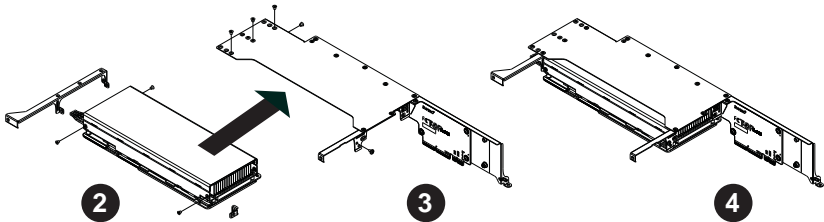
1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Secure the mounting bracket with one screw.
3. Insert the GPU into the GPU bracket and secure with three screws.
4. Confirm that the GPU is securely mounted in the GPU bracket.

Figure 6-18: Installing the Front 10" AMD Woodier GPU into the Bracket

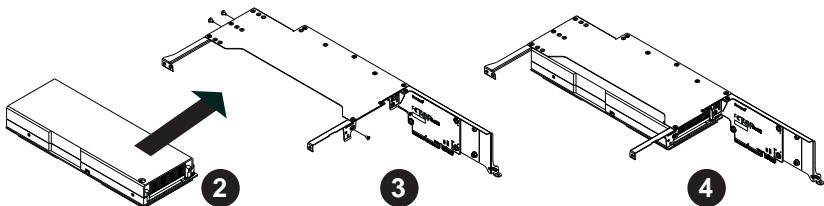


Installing a Front 10" Intel Phi GPU into a Bracket

1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Secure both mounting brackets with three screws.
3. Insert the GPU into the GPU bracket and secure with five screws.
4. Confirm that the GPU is securely mounted in the GPU bracket

Figure 6-19: Installing the Front 10" Intel Phi GPU into the Bracket**Installing a Front 10" NVIDIA GPU into a Bracket**

1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Position the NVIDIA GPU as illustrated below.
3. Insert the GPU into the GPU bracket and secure with four screws.
4. Confirm that the GPU is securely mounted in the GPU bracket..

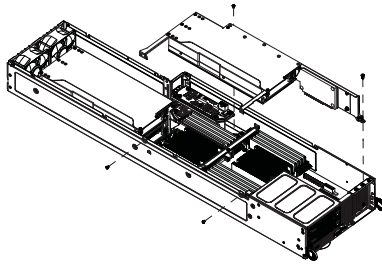
Figure 6-20: Installing the Front 10" NVIDIA GPU into the Bracket

Installing a Front 10.5" GPU into the Node

Installing a Front GPU into a Node

1. Confirm that the GPU has been correctly installed in the GPU bracket as described in the previous section.
2. Position the GPU bracket in the node as illustrated below.
3. Secure the GPU bracket to the node as shown using the four screws provided.
4. Proceed to the next section to install the rear internal 13" GPUs.

Figure 6-21: Installing the Front 10" Internal GPU into the Node

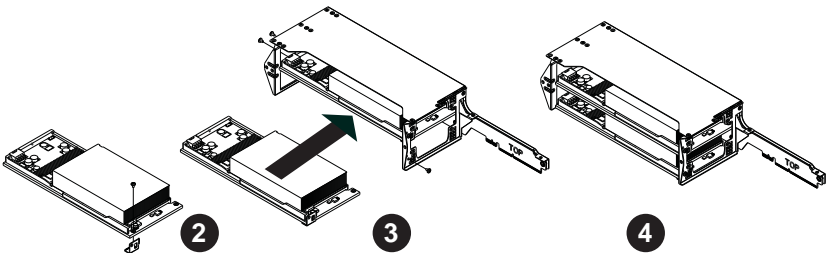


Installing Rear 13" GPUs into the Node

Installing a Rear 13" AMD Woodier GPU into a Bracket

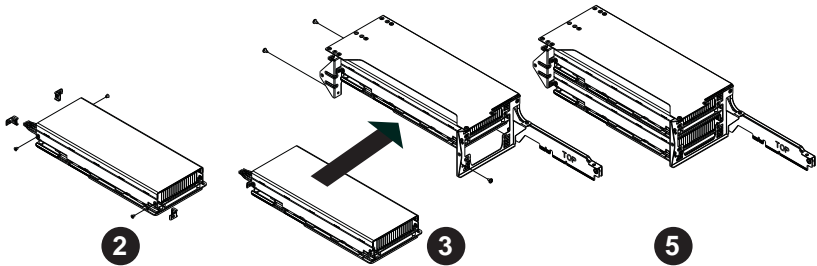
1. Confirm that the front GPU has been correctly installed as described in the previous section.
2. Secure the mounting bracket with one screw
3. Insert the GPU into the GPU bracket and secure with three screws
4. Confirm that the GPU is securely mounted in the GPU bracket.

Figure 6-22: Installing the Rear 13" AMD Woodier GPU into the Bracket

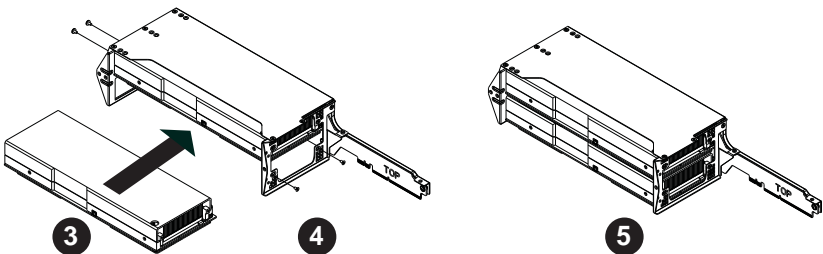


Installing a Rear 13" Intel Phi GPU into a Bracket

1. Confirm that the front GPU has been correctly installed as described in the previous section.
2. Secure the three mounting brackets with three screw.
3. Insert the GPU into the GPU bracket and secure with three screws.
4. Confirm that the GPU is securely mounted in the GPU bracket.

Figure 6-23: Installing the Rear 13" Intel Phi GPU into the Bracket**Installing a Rear 13" NVIDIA GPU into a Bracket**

1. Confirm that the front GPU has been correctly installed as described in the previous section.
2. Position the NVIDIA GPU as shown.
3. Insert the GPU into the GPU bracket and secure with four screws.
4. Confirm that the GPU is securely mounted in the GPU bracket.

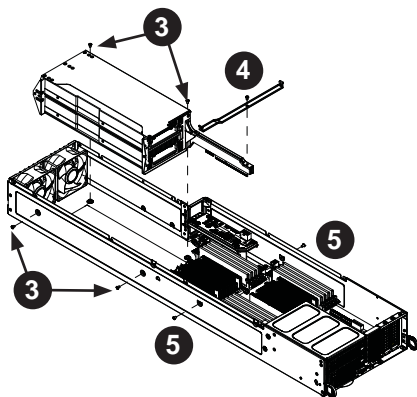
Figure 6-24: Installing the Rear 13" NVIDIA GPU into the Bracket

Installing Rear 13" GPUs into a Node

Installing a Front GPU into a Node

1. Confirm that the GPU has been correctly installed in the GPU bracket as described in the previous section.
2. Position the GPU bracket in the node as illustrated below.
3. Secure the GPU bracket to the node as shown using the four screws provided.
4. Attach the stabilizing bracket to the GPU bracket.
5. Secure the stabilizing bracket to the node with two screws.
6. Return the node to the chassis, reconnect the cord to the power supply and power up the system.

Figure 6-25: Installing the Rear 13" GPU into the Node



6-13 Installing the Air Shroud

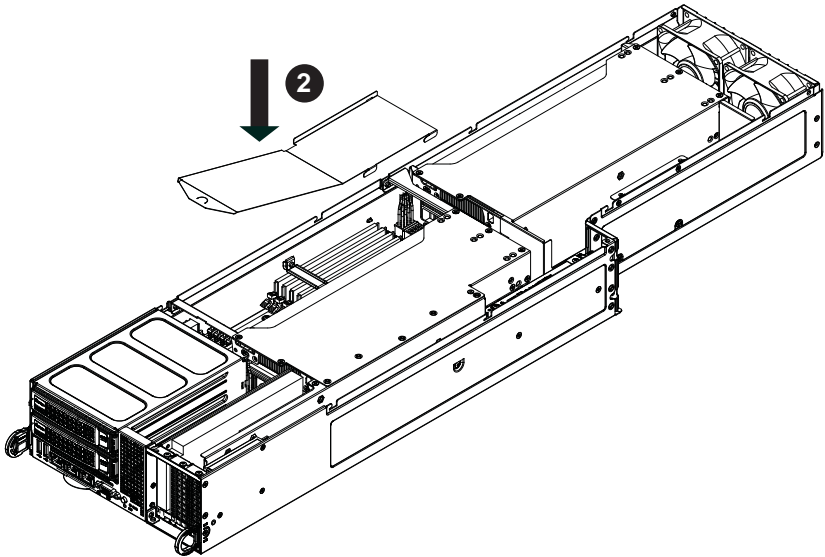
Air Shrouds

Air shrouds concentrate airflow to maximize fan efficiency. The SCF424AG/BG chassis requires an air shroud in each motherboard node.

Installing the Air Shroud

1. Remove the power cord from the rear of the node as described in Section 6-3. Remove the node from the chassis as described in Section 6-4. Place the node on a flat, stable surface and remove the node cover as described in Section 6-7.
2. Make sure that the motherboard and all components are properly installed in each motherboard node.
3. Place the air shroud over the motherboard, as illustrated below. The air shroud sits behind the hard drive bays and goes over the top of the motherboard and its components.
4. Repeat the procedure for the remaining three motherboard nodes.

Figure 6-26: Installing the Air Shroud



6-14 Checking the Airflow

Checking Airflow

1. Make sure there are no objects to obstruct airflow in and out of the server. In addition, if you are using a front bezel, make sure the bezel's filter is replaced periodically.
2. Do not operate the server without drive carriers and either a drive or dummy drive in the carrier. Use only recommended server parts.
3. Make sure no wires or foreign objects obstruct airflow through the chassis. Pull all excess cabling out of the airflow path or use shorter cables.

Installation Complete

In most cases, the node power supplies and fans are pre-installed. If you need to install fans or power supplies, continue to the Systems Fan and Power Supply sections of this chapter. If the chassis will be installed into a rack, continue to the next chapter for rack installation instructions.

6-15 Replacing System Fans

Each node supports rear exhaust fans that provide cooling for the node. These fans circulate air through the node as a means of lowering the internal temperature. In the unlikely event of a fan failure, the F424AG fans are easily removed from the rear of the node without tools.

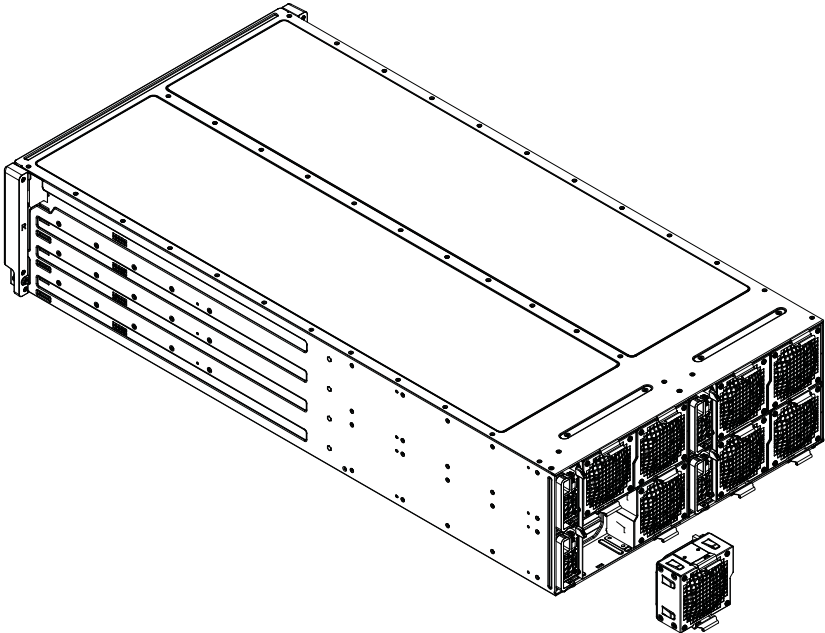
Removing a Rear Exhaust Fan

1. Determine which node contains the failed fan and power down the node with the operating system.
2. Remove the power cord from the rear of the node as described Section 6-3.
3. Press the release tab on the bottom of the fan and pull it away from rear of the node.

Installing a Rear Exhaust Fan

1. Press the release tab on the bottom of the fan and insert it into the open fan bay.
2. Push the fan into the bay until it clicks into the locked position.

Figure 6-27: Replacing a Rear Exhaust Fans



6-16 Replacing the Power Supply

The F424AG chassis includes a 1620 Watt power supply. This power supply is auto-switching capable. This enables it to automatically sense and operate at a 100v to 240v input voltage. An amber light will be illuminated on the power supply when the power is off. An illuminated green light indicates that the power supply is operating.

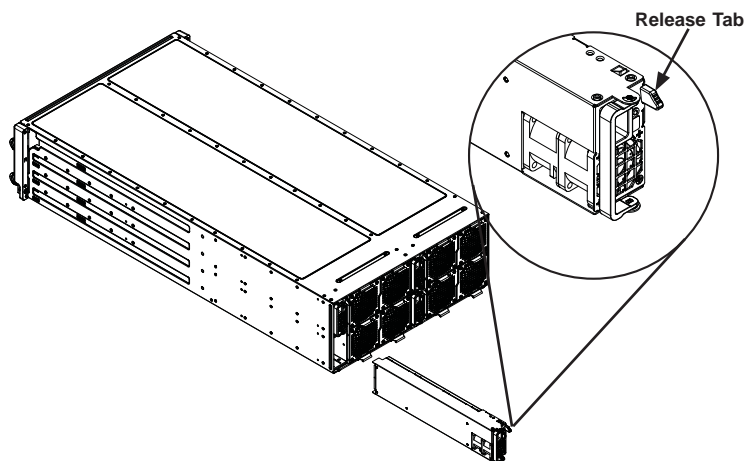
Power Supply Replacement

The F424AG chassis models utilize redundant power supplies, with a total of four in the chassis. In the unlikely event that the power supply unit needs to be replaced, one power supply can be removed, without powering down the system. Replacement units can be ordered directly from Supermicro (See the contact information in the Preface of this manual).

Changing the Power Supply

1. Disconnect the power cord on the back of the failed power supply as described in Section 6-3.
2. Press the release tab on the back of the power supply and pull the power supply out using the handle provided.
3. Push the replacement power supply module into the power bay until it clicks into the locked position.
4. Plug the AC power cord back into the module and return the node to its bay in the chassis.

Figure 6-28: Changing the Power Supply



Chapter 7

BIOS

7-1 Introduction

This chapter describes the AMI BIOS Setup utility for the X9DRFF-iG+/iTG+/7G+/7TG+. It also provides the instructions on how to navigate the AMI BIOS Setup utility screens. The AMI ROM BIOS is stored in a Flash EEPROM and can be easily updated.

Starting BIOS Setup Utility

To enter the AMI BIOS Setup utility screens, press the key while the system is booting up.

Note: In most cases, the key is used to invoke the AMI BIOS setup screen. There are a few cases when other keys are used, such as <F3>, <F4>, etc.

Each main BIOS menu option is described in this manual. The Main BIOS setup menu screen has two main frames. The left frame displays all the options that can be configured. Grayed-out options cannot be configured. Options in blue can be configured by the user. The right frame displays the key legend. Above the key legend is an area reserved for informational text related to the option currently selected in the left frame.

Note: The AMI BIOS has default informational messages built in. The manufacturer retains the option to include, omit, or change any of these informational messages.

The AMI BIOS Setup utility uses a key-based navigation system called "hot keys." Most of the AMI BIOS setup utility "hot keys" can be used at any time during setup navigation. These keys include <F3>, <F4>, <Enter>, <ESC>, arrow keys, etc.

Note 1: In this section, options printed in **Bold** are default settings.

Note 2: <F3> is used to load optimal default settings. <F4> is used to save the settings and exit the setup utility.

How To Change the Configuration Data

The configuration data that determines the system parameters may be changed by entering the AMI BIOS Setup utility. This Setup utility can be accessed by pressing <Delete> at the appropriate time during system boot.

Note: For AMI UEFI BIOS Recovery, please refer to the UEFI BIOS Recovery User Guide posted @<http://www.supermicro.com/support/manuals/>.

Starting the Setup Utility

Normally, the only visible Power-On Self-Test (POST) routine is the memory test. As the memory is being tested, press the <Delete> key to enter the main menu of the AMI BIOS Setup utility. From the main menu, you can access the other setup screens. An AMI BIOS identification string is displayed at the left bottom corner of the screen below the copyright message.

Warning! Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall the manufacturer be liable for direct, indirect, special, incidental, or consequential damage arising from a BIOS update. If you have to update the BIOS, do not shut down or reset the system while the BIOS is being updated to avoid possible boot failure.

7-2 Main Setup

When you first enter the AMI BIOS Setup utility, you will enter the Main setup screen. You can always return to the Main setup screen by selecting the Main tab on the top of the screen. The Main BIOS Setup screen is shown below.



The AMI BIOS main menu displays the following information:

System Date

This item displays the system date in Day MM/DD/YY format (e.g. Sat 10/20/2012).

System Time

This item displays the system time in HH:MM:SS format (e.g. 15:32:52).

Supermicro X9DRFF-iG+/iTG+/7G+/7TG+

Version

This item displays the SMC version of the BIOS ROM used in this system.

Build Date

This item displays the date that the BIOS ROM was built.

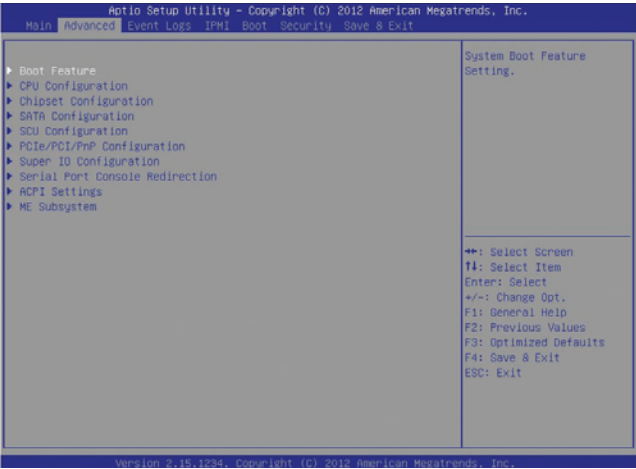
Memory Information

Total Memory

This displays the amount of memory available in the system.

7-3 Advanced Setup Configurations

Use the arrow keys to select the Advanced Setup submenu and press <Enter> to access the following items.



Boot Feature

Quiet Boot

Use this item to select bootup screen display between POST messages and the OEM logo. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options are **Enabled** and Disabled.

AddOn ROM Display Mode

Use this item to set the AddOn Option ROM display mode. Select Keep Current to use the current Option ROM display mode. Select Force BIOS to use the Option ROM display mode set by the system BIOS. The options are **Force BIOS** and Keep Current.

Bootup Num-Lock

Use this feature to set the Power-on state for the Num Lock key on the keyboard. The options are Off and **On**.

Wait For 'F1' If Error

Select Enabled to force the system to wait until the 'F1' key is pressed if an error occurs. The options are Disabled and **Enabled**.

Interrupt 19 Capture

Interrupt 19 is the software interrupt that handles the boot disk function. When this item is set to Enabled, the ROM BIOS of the host adaptors will "capture" Interrupt 19 at bootup and allow the drives that are attached to these host adaptors to function as bootable disks. If this item is set to Disabled, the ROM BIOS of the host adaptors will not capture Interrupt 19, and the drives attached to these adaptors will not function as bootable devices. The options are **Enabled** and Disabled.

Re-try Boot

When the feature is set to Enabled, the BIOS will continuously retry to boot from the selected boot type. The options are **Disabled**, Legacy Boot, and EFI Boot.

Power Configuration

Watch Dog Function

If enabled, the Watch Dog timer will set the system to automatically reboot when a non-recoverable error occurs, and this error lasts for more than five minutes. The options are Enabled and **Disabled**.

Power Button Function

If this feature is set to Instant Off, the system will power off immediately as soon as the user presses the power button. If this feature is set to 4 Seconds Override, the system will power off when the user presses the power button for 4 seconds or longer. The options are **Instant Off** and 4 Seconds Override.

Restore on AC Power Loss

Use this feature to set the power state after a power outage. Select Stay Off for the system power to remain off after a power loss. Select Power On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last state before a power loss. The options are Power On, Stay Off, and **Last State**.

CPU Configuration

This submenu displays CPU information as detected by the BIOS. It also allows the user to configure CPU settings.

► Socket 1 CPU Information, Socket 2 CPU Information

This submenu displays the following information on the CPUs installed in Socket 1 and Socket 2.

- Type of CPU
- CPU Signature
- Microcode Patch
- CPU Stepping
- Maximum CPU Speed
- Minimum CPU Speed
- Processor Cores
- Intel HT (Hyper-Threading) Technology
- Intel VT-x Technology
- Intel SMX Technology
- L1 Data Cache
- L1 Code Cache
- L2 Cache
- L3 Cache

CPU Speed

This item displays the speed of the CPU installed in the Socket specified.

64-bit

This item indicates if 64-bit technology is supported by the CPU installed in the Socket selected.

Clock Spread Spectrum

Select Enable to enable Clock Spectrum support, which will allow the BIOS to monitor and attempt to reduce Electromagnetic Interference level caused by the components whenever needed. The options are **Disabled** and Enabled.

RTID (Record Types IDs)

This feature displays the total number of Record Type IDs for local and remote pools. The options are **Optimal** and Alternate.

Hyper-threading

Select Enabled to support Intel Hyper-threading Technology to enhance CPU performance. The options are **Enabled** and Disabled.

Active Processor Cores

Set to Enabled to use the processor's second core and above. (Please refer to Intel's website for more information.) The options are **All**, 1, 2, 4, and 6.

Limit CPUID Maximum

Use this feature to set the maximum CPU ID value. Enable this function to boot legacy operating systems that do not support processors with extended CPUID functions. The options are Enabled and **Disabled** (for the Windows OS).

Execute Disable Bit (Available if supported by the OS & the CPU)

Select Enabled to enable the Execute Disable Bit which will allow the processor to designate areas in the system memory where an application code can execute and where it cannot, thus preventing a worm or a virus from flooding illegal codes to overwhelm the processor or damage the system during an attack. The default is **Enabled**. (Refer to Intel and Microsoft Web sites for more information.)

Intel® AES-NI

Select Enable to use the Intel Advanced Encryption Standard (AES) New Instructions (NI) to ensure data security. The options are **Enabled** and Disabled.

MLC Streamer Prefetcher (Available when supported by the CPU)

If set to Enabled, the MLC (Mid-Level Cache) streamer prefetcher will prefetch streams of data and instructions from the main memory to the L2 cache in the CPU to improve CPU performance. The options are Disabled and **Enabled**.

MLC Spatial Prefetcher (Available when supported by the CPU)

If this feature is set to Disabled, the MLC spatial prefetcher will prefetch the cache line for 64 bytes. If this Enabled, the MLC spatial prefetcher will prefetch both cache lines for 128 bytes as comprised. The options are Disabled and **Enabled**.

DCU Streamer Prefetcher (Available when supported by the CPU)

If this item is set to Enabled, the Data Cache Unit (DCU) streamer prefetcher will prefetch L1 data to speed up data accessing and processing to enhance CPU performance. The options are Disabled and **Enabled**.

DCU IP Prefetcher

Select Enabled for DCU (Data Cache Unit) IP Prefetcher support, which will prefetch IP addresses to improve network connectivity and system performance. The options are **Enabled** and Disabled.

Intel® Virtualization Technology (Available when supported by the CPU)

Select Enabled for Intel Virtualization Technology support, which will allow one platform to run multiple operating systems and applications in independent partitions, creating multiple "virtual" systems in one physical computer. The options are **Enabled** and Disabled.

Note: If there is any change to this setting, you will need to power off and restart the system for the change to take effect. Please refer to Intel's website for detailed information.)

► CPU Power Management Configuration

This submenu allows the user to configure the following CPU Power Management settings.

Power Technology

Select Energy Efficiency to support power-saving mode. Select Custom to customize system power settings. Select Disabled to disable power-saving settings. The options are Disabled, **Energy Efficient**, and Custom. If the option is set to Custom, the following items will display:

EIST (Available when Power Technology is set to Custom)

EIST (Enhanced Intel SpeedStep Technology) allows the system to automatically adjust processor voltage and core frequency to reduce power consumption and heat dissipation. The options are Disabled and **Enabled**.

C1E Support (Available when Power Technology is set to Custom)

Select Enabled to enable Enhanced C1 Power State to boost system performance. The options are **Enabled** and Disabled.

CPU C3 Report (Available when Power Technology is set to Custom)

Select Enabled to allow the BIOS to report the CPU C3 State (ACPI C2) to the operating system. During the CPU C3 State, the CPU clock generator is turned off. The options are Enabled and **Disabled**.

CPU C6 Report (Available when Power Technology is set to Custom)

Select Enabled to allow the BIOS to report the CPU C6 State (ACPI C3) to the operating system. During the CPU C6 State, the power to all cache is turned off. The options are **Enabled** and Disabled.

CPU C7 Report (Available when Power Technology is set to Custom)

Select Enabled to allow the BIOS to report the CPU C7 State (ACPI C3) to the operating system. CPU C7 State is a processor-specific low C-State. The options are **Enabled** and Disabled.

Package C-State limit (Available when Power Technology is set to Custom)

Use this feature to set the limit on the C-State package register. The options are C0, C2, **C6**, and No Limit.

Energy Performance Bias

Use this feature to select an appropriate fan setting to maximize system performance (with maximum cooling) or to maximize energy efficiency with maximum power saving). The fan speeds are controlled by firmware management via IPMI 2.0. The options are Performance, **Balanced Performance**, Balanced Energy, and Energy Efficient.

Factory Long Duration Power Limit

This item displays the power limit (in watts) set by the manufacturer during which long duration power is maintained.

Long Duration Power Limit

This item displays the power limit (in watts) set by the user during which long duration power is maintained. The default setting is **0**.

Factory Long Duration Maintained

This item displays the period of time (in seconds) set by the manufacturer during which long duration power is maintained.

Long Duration Maintained

This item displays the period of time (in seconds) during which long duration power is maintained. The default setting is **0**.

Recommended Short Duration Power Limit

This item displays the short duration power settings (in watts) recommended by the manufacturer.

Short Duration Power Limit

This item displays the time period during which short duration power (in watts) is maintained. The default setting is **0**.

► Chipset Configuration**► North Bridge**

This feature allows the user to configure the settings for the Intel North Bridge.

► Integrated IO Configuration**Intel® VT-d**

Select **Enabled** to enable Intel Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to the VMM (Virtual Machine Monitor) through the DMAR ACPI tables. This feature offers fully-protected I/O -resource sharing across Intel platforms, providing greater reliability, security and availability in networking and data-sharing. The options are **Enabled** and **Disabled**.

Aging Timer Rollover

Use this feature to configure Aging Timer Rollover settings. Select **Default** to allow the BIOS to configure Aging Timer Roller settings. The options are **Default**, **Disabled**, **32us**, **128 us** and **512 us**.

Intel® I/OAT

Select **Enabled** to enable Intel I/OAT (I/O Acceleration Technology), which significantly reduces CPU overhead by leveraging CPU architectural demands, freeing up the system resource for other tasks. The options are **Disabled** and **Enabled**.

DCA Support

Select **Enabled** to use Intel's DCA (Direct Cache Access) Technology to improve data transfer efficiency. The default setting is **Enabled**.

MMCFG BASE

This feature determines the lowest base address that can be assigned to PCI devices. The lower the address, the less system memory is available (for 32-bit OS). The higher the address, the less resources are allocated to PCI devices. The options are **0x80000000**, **0xA0000000**, and **0xC0000000**.

I/O 1 PCIe Port Bifurcation Control

This submenu configures the following IO PCIe Port Bifurcation Control settings for the PCIe ports. It also determines how the available PCI-Express lanes are distributed between the PCI-Exp. Root ports.

CPU 1 Slot J1 PCI-E 3.0 x16 Link Speed

Select **GEN1** to enable PCI-Exp Generation 1 support for Slot J1. Select **GEN2** to enable PCI-Exp Generation 2 support for Slot J1. Select **GEN3** to enable PCI-Exp Generation 3 support for Slot J1. The options are **GEN1**, **GEN2**, and **GEN3**.

CPU 1 Slot J2 PCI-E 3.0 x8 Link Speed

Select **GEN1** to enable PCI-Exp Generation 1 support for Slot J2. Select **GEN2** to enable PCI-Exp Generation 2 support for Slot J2. Select **GEN3** to enable PCI-Exp Generation 3 support for Slot J2. The options are **GEN1**, **GEN2**, and **GEN3**.

CPU 1 Slot J3 PCI-E 3.0 x8 Link Speed

Select **GEN1** to enable PCI-Exp Generation 1 support for Slot J3. Select **GEN2** to enable PCI-Exp Generation 2 support for Slot J3. Select **GEN3** to enable PCI-Exp Generation 3 support for Slot J3. The options are **GEN1**, **GEN2**, and **GEN3**.

I/O 2 PCIe Port Bifurcation Control

This submenu configures the following IO PCIe Port Bifurcation Control settings for the PCIe ports. It also determines how the available PCI-Express lanes are distributed between the PCI-Exp. Root Ports.

CPU 2 Slot SXB1A PCI-E 3.0 x16 Link Speed

Select GEN1 to enable PCI-Exp Generation 1 support for Slot SXB1A. Select GEN2 to enable PCI-Exp Generation 2 support for Slot SXB1A. Select GEN3 to enable PCI-Exp Generation 3 support for Slot SXB1A. The options are GEN1, GEN2, and **GEN3**.

CPU 2 Slot SXB1B PCI-E 3.0 x16 Link Speed

Select GEN1 to enable PCI-Exp Generation 1 support for Slot SXB1B. Select GEN2 to enable PCI-Exp Generation 2 support for Slot SXB1B. Select GEN3 to enable PCI-Exp Generation 3 support for Slot SXB1B. The options are GEN1, GEN2, and **GEN3**.

► QPI Configuration**Current QPI Link Speed**

This item displays the current speed of the QPI Link.

Current QPI Link Frequency

This item displays the frequency of the QPI Link.

Isoc

Select Enabled to enable Isochronous support to meet QoS (Quality of Service) requirements. This feature is especially important for virtualization technology. The options are Enabled and **Disabled**.

QPI (Quick Path Interconnect) Link Speed Mode

Use this feature to select data transfer speed for QPI Link connections. The options are **Fast** and Slow.

QPI Link Frequency Select

Use this feature to select the desired QPI frequency. The options are **Auto**, 6.4 GT/s, 7.2 GT/s, and 8.0 GT/s.

► DIMM Configuration

This section displays the following DIMM information.

Current Memory Mode

This item displays the current memory mode.

Current Memory Speed

This item displays the current memory speed.

Mirroring

This item displays if memory mirroring is supported by the motherboard. Memory mirroring creates a duplicate copy of the data stored in the memory to enhance data security.

Sparing

This item displays if memory sparing is supported by the motherboard. Memory sparing enhances system performance.

►DIMM Information

The submenu displays the status of a DIMM module detected by the BIOS.

CPU Socket 1 DIMM Information/CPU Socket 2 DIMM Information

Memory Mode

When Independent is selected, all DIMMs are available to the operating system. When Mirroring is selected, the motherboard maintains two identical copies of all data in memory for data backup. When Lockstep is selected, the motherboard uses two areas of memory to run the same set of operations in parallel. The options are **Independent**, Mirroring, and Lockstep.

DRAM RAPL Mode

RAPL (Running Average Power Limit) provides mechanisms to enforce power consumption limits on supported processors. The options are DRAM RAPL MODE0, **DRAM RAPL MODE1**, and Disabled.

DDR Speed

Use this feature to force a DDR3 memory module to run at a frequency other than what is specified by the manufacturer. The options are **Auto**, Force DDR3-800, Force DDR3-1066, Force DDR3-1333, Force DDR3-1600 and Force SPD.

Channel Interleaving

This feature selects from the different channel interleaving methods. The options are **Auto**, 1 Way, 2 Way, 3, Way, and 4 Way.

Rank Interleaving

This feature allows the user to select a rank memory interleaving method. The options are **Auto**, 1 Way, 2 Way, 4, Way, and 8 Way.

Patrol Scrub

Patrol Scrubbing is a process that allows the CPU to correct correctable memory errors detected on a memory module and send the correction to the requestor (the original source). When this item is set to Enabled, the IO hub will read and write back one cache line every 16K cycles if there is no delay caused by internal processing. By using this method, roughly 64 GB of memory behind the IO hub will be scrubbed every day. The options are **Enabled** and Disabled.

Demand Scrub

Demand Scrubbing is a process that allows the CPU to correct correctable memory errors found on a memory module. When the CPU or I/O issues a demand-read command, and the read data from memory turns out to be a correctable error, the error is corrected and sent to the requestor (the original source). Memory is updated as well. Select Enabled to use Demand Scrubbing for ECC memory correction. The options are Enabled and **Disabled**.

Data Scrambling

Select Enabled to enable data scrambling to ensure data security and integrity. The options are Disabled and **Enabled**.

Device Tagging

Select Enabled to support device tagging. The options are **Disabled** and Enabled.

Thermal Throttling

Throttling improves CPU reliability and reduces power consumption via automatic voltage control during processor idle states. The options are Disabled and **CLTT** (Closed Loop Thermal Throttling).

► South Bridge Configuration

This feature displays PCH information and allows the user to configure PCH settings.

PCH Information

The following PCH information will be displayed.

- **Name:** This item displays the name of the PCH chip.
- **Stepping:** This item displays the PCH stepping.
- **USB Devices:** This item displays the USB devices detected by the BIOS.

All USB Devices

Select Enabled to enable all USB ports/devices. The options are Disabled and **Enabled**.

EHCI Controller 1/EHCI Controller 2 (Available when All USB Devices is set to Enabled)

Select Enabled to enable EHCI (Enhanced Host Controller Interface) Controller 1 or Controller 2. The options are Disabled and **Enabled**.

Legacy USB Support (Available when USB Functions is not Disabled)

Select Enabled to support legacy USB devices. Select Auto to disable legacy support if USB devices are not present. Select Disabled to have USB devices available for EFI (Extensive Firmware Interface) applications only. The settings are Disabled, **Enabled** and Auto.

Port 60/64 Emulation

Select Enabled to enable I/O port 60h/64h emulation support for the legacy USB keyboard so that it can be fully supported by the operating systems that does not recognize a USB device. The options are Disabled and **Enabled**.

EHCI Hand-Off

This item is for operating systems that do not support Enhanced Host Controller Interface (EHCI) hand-off. When this feature is enabled, EHCI ownership will be changed by the EHCI driver. The options are **Disabled** and Enabled.

► SATA Configuration

When this submenu is selected, the AMI BIOS automatically detects the presence of IDE or SATA devices and displays the following items.

SATA Port0~SATA Port5

The AMI BIOS displays the status of each SATA port as detected by the BIOS.

SATA Mode

Use this feature to configure SATA mode for a selected SATA port. The options are Disabled, IDE Mode, **AHCI Mode** and RAID Mode. The following are displayed depending on your selection:

IDE Mode

The following items are displayed when IDE Mode is selected:

Serial-ATA (SATA) Controller 0~1

Use this feature to activate or deactivate the SATA controller, and set the compatibility mode. The options are Disabled, Enhanced, and Compatible. The default for SATA Controller 0 is **Compatible**. The default of SATA Controller 1 is **Enhanced**.

AHCI Mode

The following items are displayed when the AHCI Mode is selected.

Aggressive Link Power Management

When Enabled, the SATA AHCI controller manages the power usage of the components installed on the SATA link. The controller will put the link in a low power mode during extended periods of I/O inactivity, and will return the link to an active state when I/O activity resumes. The options are **Enabled** and Disabled.

Port 0~5 Hot Plug

Select Enabled to enable hot-plug support for a particular port, which will allow the user to change a hardware component or device without shutting down the system. The options are **Enabled** and Disabled.

Port 0~5 Staggered Spin-Up

Select Enabled to enable Staggered Spin-up support to prevent excessive power consumption caused by multiple HDDs spinning-up simultaneously. The options are Enabled and **Disabled**.

RAID Mode

The following items are displayed when RAID Mode is selected:

SATA RAID Option ROM/UEFI Driver

Use this feature to enable the onboard SATA Option ROM or EFI driver. The options are Enabled and **Disabled**.

Port 0~5 Hot Plug

Select Enabled to enable hot-plug support for the particular port. The options are Disabled and **Enabled**.

► PCIe/PCI/PnP Configuration

Launch Storage Add-on Card OpROM Priority

Use this feature to select the Option ROM you want to use to boot the system when there are multiple Option ROMs available in the system. The options are UEFI only and **Legacy only**.

PCI Latency Timer

Use this feature to set the latency timer of each PCI device installed on a PCI bus. Select 64 to set the PCI latency to 64 PCI clock cycles. The options are 32, **64**, 96, 128, 160, 192, 224 and 248.

PERR# Generation

Select Enabled to allow a PCI device to generate a PERR number for a PCI Bus Signal Error Event. The options are Enabled and **Disabled**.

SERR# Generation

Select Enabled to allow a PCI device to generate an SERR number for a PCI Bus Signal Error Event. The options are Enabled and **Disabled**.

Maximum Payload

Select Auto to allow the system BIOS to automatically set the maximum payload value for a PCI-E device to enhance system performance. The options are **Auto**, 128 Bytes and 256 Bytes, 512 Bytes, 1024 Bytes, 2048 Bytes, and 4096 Bytes.

Maximum Read Request

Select Auto to allow the system BIOS to automatically set the maximum Read Request size for a PCI-E device to enhance system performance. The options are **Auto**, 128 Bytes, 256 Bytes, 512 Bytes, 1024 Bytes, 2048 Bytes, and 4096 Bytes.

ASPM Support

Use this feature to set the Active State Power Management (ASPM) level for a PCI-E device. Select Auto to allow the system BIOS to automatically set the ASPM level for the system. Select Disabled to disable ASPM support. The options are **Disabled**, and Auto.

Warning: Enabling ASPM support may cause some PCI-E devices to fail!

Above 4G Decoding (Available if the system supports 64-bit PCI decoding)

Select Enabled to decode a PCI device that supports 64-bit in the space above 4G Address. The options are Enabled and **Disabled**.

CPU1 Slot J1 PCI-E 3.0 x16 OPROM

Select Enabled to enable Option ROM support to boot the computer using a device installed on the slot specified above. The options are **Enabled** and Disabled.

CPU1 Slot J2/Slot J3 PCI-E 3.0 x8 OPROM

Select Enabled to enable Option ROM support to boot the computer using a device installed on the slot specified above. The options are **Enabled** and Disabled.

PCH Slot J4 PCI-E 2.0 x4 OPROM

Select Enabled to enable Option ROM support to boot the computer using a device installed on the slot specified above. The options are **Enabled** and Disabled.

CPU2 Slot SXB1A/Slot SXB1B PCI-E 3.0 x16 OPROM

Select Enabled to enable Option ROM support to boot the computer using a device installed on the slot specified above. The options are **Enabled** and Disabled.

Onboard LAN Option ROM Select

Select iSCSI to use the iSCSI Option ROM to boot the computer using a network device. Select PXE (Preboot Execution Environment) to use an PXE Option ROM to boot the computer using a network device. The options are **PXE**, iSCSI and FCoE.

Load Onboard LAN1 Option ROM/Load Onboard LAN2 Option ROM

Select Enabled to enable the onboard LAN1 or LAN2 Option ROM. This is to boot the computer using a network device. The default setting for LAN1 Option ROM is **Enabled**, and for LAN2 Option ROM is **Disabled**.

Load Onboard SAS OPROM

Select Enabled for onboard SAS Option ROM support. This is to boot the computer using a SAS device. The options are Disabled and **Enabled**.

VGA Priority

This feature allows the user to select the graphics adapter to be used as the primary boot device. The options are **Onboard**, and Offboard.

Network Stack

Select Enabled enable PXE (Preboot Execution Environment) or UEFI (Unified Extensible Firmware Interface) for network stack support. The options are Enabled and **Disabled**.

IPv4 PXE Support (Available when Network Stack is set to Enabled)

Set this item to Enabled to activate IPv4 PXE Support. The options are **Enabled** and Disabled.

IPv6 PXE Support (Available when Network Stack is set to Enabled)

Set this item to Enabled to activate IPv6 PXE Support. The options are Enabled and **Disabled**.

► Serial Port Console Redirection**COM 1/SOL**

These two submenus allow the user to configure the following Console Redirection settings for a COM port specified by the user.

COM1/SOL (Serial Over LAN) Console Redirection

Select Enabled to use COM1 or SOL (Serial_Over_LAN) port selected by the user for Console Redirection. The options are Enabled and Disabled. The default setting for COM1 is **Disabled**, and for SOL is **Enabled**.

► Console Redirection Settings

Use this feature to specify how the host computer will communicate with the client computer, which is the remote computer used by the user.

Terminal Type

This feature allows the user to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII Character set. Select VT100+ to add color and function key support. Select ANSI to use the Extended ASCII Character Set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, **VT100+**, and VT-UTF8.

Bits Per second

Use this feature to set the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 38400, 57600 and **115200** (bits per second).

Data Bits

Use this feature to set the data transmission size for Console Redirection. The options are 7 Bits and **8 Bits**.

Parity

A parity bit can be sent along with regular data bits to detect data transmission errors. Select Even if the parity bit is set to 0, and the number of 1's in data bits is even. Select Odd if the parity bit is set to 0, and the number of 1's in data bits is odd. Select None if you do not want to send a parity bit with your data bits in transmission. Select Mark to add a mark as a parity bit to be sent along with the data bits. Select Space to add a Space as a parity bit to be sent with your data bits. The options are **None**, Even, Odd, Mark and Space.

Stop Bits

A stop bit indicates the end of a serial data packet. Select 1 Stop Bit for standard serial data communication. Select 2 Stop Bits if slower devices are used. The options are **1** and **2**.

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start sending data when the receiving buffer is empty. The options are **None** and Hardware RTS/CTS.

VT-UTF8 Combo Key Support

Select Enabled to enable VT-UTF8 Combination Key support for ANSI/VT100 terminals. The options are **Enabled** and Disabled.

Recorder Mode

Select Enabled to capture the data displayed on a terminal and send it as text messages to a remote server. The options are **Disabled** and Enabled.

Resolution 100x31

Select Enabled for extended-terminal resolution support. The options are Disabled and **Enabled**.

Legacy OS Redirection Resolution

Use this feature to select the number of rows and columns used in Console Redirection for legacy OS support. The options are 80x24 and **80x25**.

Putty KeyPad

This feature selects Function Keys and KeyPad settings for Putty, which is a terminal emulator designed for the Windows OS. The options are **VT100**, LINUX, XTERMR6, SCO, ESCN, and VT400.

Redirection After BIOS Post

Use this feature to enable or disable Legacy Console Redirection after BIOS POST (Power On Self Test). When this feature is set to Bootloader, Legacy Console Redirection is disabled before booting the OS. When this feature is set to Always Enable, Legacy Console Redirection remains enabled during OS bootup. The options are **Always Enable** and Bootloader.

Serial Port for Out-of-Band Management/Windows Emergency Management Services (EMS)

The submenu allows the user to configure Console Redirection settings to support Out-of-Band Serial Port management.

EMS Console Redirection

Select Enabled to select a COM Port for Console Redirection. The options are Enabled and **Disabled**.

► Console Redirection Settings (for EMS)

This feature allows the user to specify how the host computer will exchange data with the client computer, which is the remote computer used by the user.

Out-of-Band Management Port

The feature selects a serial port used by the Microsoft Windows Emergency Management Services (EMS) to communicate with a remote server. The options are **COM1** and SOL.

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, **VT100+**, and VT-UTF8.

Bits Per Second

This item sets the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 57600, and **115200** (bits per second).

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a Stop signal to stop sending data when the receiving buffer is full. Send a Start signal to start sending data when the receiving buffer is empty. The options are **None**, Hardware RTS/CTS, and Software Xon/Xoff.

Data Bits, Parity, Stop Bits

The setting for each of these items is displayed.

► ACPI Settings

Use this feature to configure Advanced Configuration and Power Interface (ACPI) power management settings for your system.

ACPI Sleep State

Use this feature to select the ACPI State when the system is in sleep mode. Select S1 (CPU Stop Clock) to erase all CPU caches and stop executing instructions. In this setting, power to the CPU(s) and RAM is maintained, but RAM is refreshed. Select Suspend Disabled to use power-reduced mode. Power will only be supplied to limited components (such as RAMs) to maintain the most critical functions of the system. The options are **S1 (CPU Stop Clock)**, and Suspend Disabled.

NUMA (NON-Uniform Memory Access)

Select Enabled to enable the Non-Uniform Memory Access ACPI support. The options are **Enabled** and Disabled.

High Precision Event Timer

Select Enabled to activate the High Precision Event Timer (HPET) that produces periodic interrupts at a much higher frequency than a Real-time Clock (RTC) does in synchronizing multimedia streams, providing smooth playback, reducing the dependency on other timestamp calculation devices, such as an x86 RDTSC Instruction embedded in the CPU. The High Performance Event Timer is used to replace the 8254 Programmable Interval Timer. The options are **Enabled** and Disabled.

► Trusted Computing (Available when a TPM device is detected by the BIOS)

Configuration

TPM Support

When this feature is set to Enabled, and the onboard TPM is also set to Enabled, you can use TPM support to improve data integrity and network security for your system. The options are **Enabled** and Disabled.

TPM State

Select Enabled to enable TPM security settings to improve data integrity and network security. The options are Disabled and **Enabled**.

Pending Operation

Use this item to schedule an operation for the security device. The options are **None**, Enable Take Ownership, Disable Take Ownership, and TPM Clear.

Note: Upon system reset, the computer will reboot in order to execute the pending operation and change the state of the security device.

Current Status Information: This item displays current TPM status.

TPM Enable Status

This item indicates if TPM is currently enabled or disabled.

TPM Active Status

This item indicates if TPM is currently active or not.

TPM Owner Status

This item displays the status of TPM Ownership.

► ME Subsystem

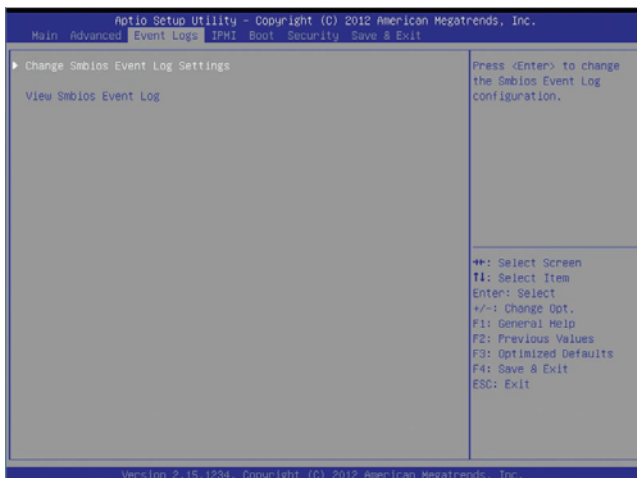
Intel ME Subsystem Configuration

This feature displays information on the Intel Management Engine subsystem:

- ME BIOS Interface Version
- ME Version

7-4 Event Logs

This submenu allows the user to configure Event Log settings.



►Change SMBIOS Event Log Settings

This feature allows the user to configure SMBIOS Event settings.

Enabling/Disabling Options

SMBIOS Event Log

Select Enabled to enable SMBIOS (System Management BIOS) event logging during system boot. The options are **Enabled** and Disabled.

Runtime Error Logging Support

Select Enabled to support runtime error logging. The options are **Enabled** and Disabled.

Memory Correctable Error Threshold

Use this feature to enter the threshold value for correctable memory errors. The default setting is **10**.

PCI Error Logging Support

Select Enabled to support error event logging for PCI slots. The options are Enabled and **Disabled**.

Erasing Settings

Erase Event Log

Select Enabled to erase the SMBIOS (System Management BIOS) Event Log, which is completed before an event logging is initialized upon system reboot. The options are **No**, Yes, next reset, and Yes, every reset.

When Log is Full

Select Erase Immediately to immediately erase SMBIOS error event logs that exceed the limit when the SMBIOS event log is full. Select Do Nothing for the system to do nothing when the SMBIOS event log is full. The options are **Do Nothing** and Erase Immediately.

SMBIOS Event Log Standard Settings

Log System Boot Event

Select Enabled to log system boot events. The options are **Disabled** and Enabled.

MECI (Multiple Event Count Increment)

Enter the increment value for the multiple event counter. Enter a number between 1 to 255. The default setting is **1**.

METW (Multiple Event Count Time Window)

This item allows the user to decide how long (in minutes) should the multiple event counter wait before generating a new event log. Enter a number between 0 to 99. The default setting is **60**.

View SMBIOS Event Log

This item displays SMBIOS event log.

7-5 IPMI

Use this feature to configure Intelligent Platform Management Interface (IPMI) settings.



IPMI Firmware Revision

This item indicates the IPMI firmware revision used in your system.

IPMI Status

This item indicates the status of the IPMI firmware installed in your system.

► System Event Log

Enabling/Disabling Options

SEL Components

Select Enabled for all system event logging at bootup. The options are **Enabled** and Disabled.

Erasing Settings

Erase SEL

Select Yes, On next reset to erase all system event logs upon next system reboot.
 Select Yes, On every reset to erase all system event logs upon each system reboot.
 Select No to keep all system event logs after each system reboot. The options are **No**, Yes, On next reset, and Yes, On every reset.

When SEL is Full

This feature allows the user to decide what the BIOS should do when the system event log is full. Select Erase Immediately to erase all events in the log when the system event log is full. The options are **Do Nothing** and Erase Immediately.

► BMC Network Configuration

LAN Channel 1

This feature is used to configure the settings for LAN1 Port.

IPMI LAN Selection

This item displays the current IPMI Selection setting.

IPMI Network Line Status

This item displays the status of the current IPMI network connection line.

Update IPMI LAN Configuration

This feature allows the BIOS to implement any IP/MAC address changes at the next system boot. If the option is set to Yes, any changes made to the settings below will take effect at the next system reboot. The options are **No** and Yes.

Configuration Address Source

Use this feature to select the source of the IP address for this computer. If Static is selected, you will need to know the IP address of this computer and enter it to the system manually in the field. If DHCP is selected, the BIOS will search for a DHCP (Dynamic Host Configuration Protocol) server in the network that it is attached to and request the next available IP address for this computer. The options for are **DHCP** and Static. The following items are assigned IP addresses automatically if DHCP is selected, or can be configured manually if Static is selected.

Station IP Address

This item displays the Station IP address for this computer. This should be in decimal and in dotted quad form (i.e., 192.168.10.253).

Subnet Mask

This item displays the sub-network that this computer belongs to. The value of each three-digit number separated by dots should not exceed 255.

Station MAC Address

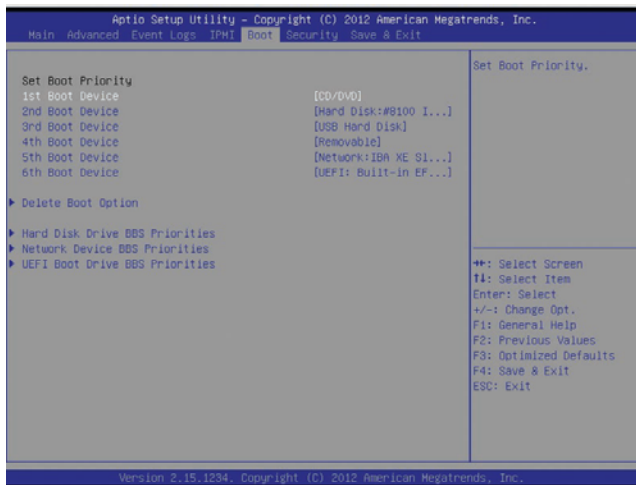
This item displays the Station MAC address for this computer. Mac addresses are 6 two-digit hexadecimal numbers.

Gateway IP Address

This item displays the Gateway IP address for this computer. This should be in decimal and in dotted quad form (i.e., 192.168.10.253).

7-6 Boot

This submenu allows the user to configure the following boot settings for the system.



Set Boot Priority

1st Boot Device, 2nd Boot Device, 3rd Boot Device, etc.

Use these items to specify the sequence of boot device priority.

► Delete Boot Option

Use this feature to select a boot device to delete from the boot priority list.

► Hard Disk Drive BBS Priorities

This item is used to select the boot device priority sequence from available hard drives.

► Network Device BBS Priorities

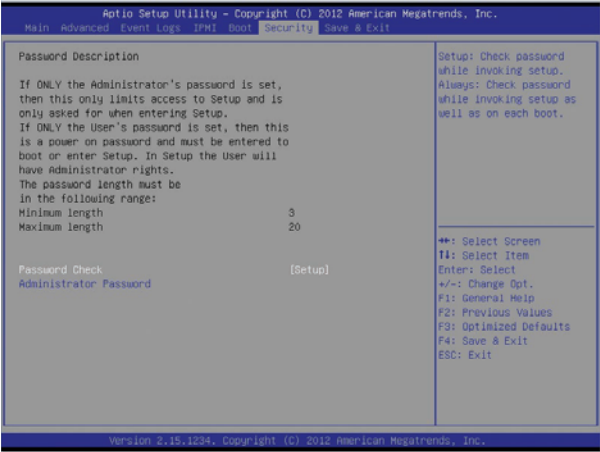
This item is used to select the boot device priority sequence from available network devices.

► **UEFI Boot Drive BBS Priorities**

This item is used to select the boot device priority sequence from available UEFI devices.

7-7 Security

This menu is used to configure the following security settings for the system.



Password Check

This feature determines when a password entry is required. If Setup is selected, the user is required to enter a password upon entering the BIOS setup utility. If Always is selected, the user is required to enter a password upon entering the BIOS setup utility and upon each system boot. The options are **Setup** and Always.

Administrator Password

Use this item to set the Administrator Password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.



Select this option to quit the BIOS Setup without making any permanent changes

When you have completed the system configuration changes, select this option to

Select this option and press **<Enter>** to save all changes you've done so far and

Discard Changes

Select this feature and press <Enter> to discard all the changes and return to the BIOS setup. When the dialog box appears, asking you if you want to load previous values, select **Yes** to load the values previous saved, or select No to keep the changes you've made so far.

Restore Optimized Defaults

Select this feature and press <Enter> to load the optimized default settings that will help optimize system performance. When the dialog box appears, asking you if you want to load optimized defaults, select **Yes** to load the optimized default settings, or select No to abandon optimized defaults.

Save as User Defaults

Select this feature and press <Enter> to save the current settings as the user's defaults. When the dialog box appears, asking you if you want to save values as user's defaults, click **Yes** to save the current values as user's default settings, or click No to keep the defaults previously saved as the user's defaults.

Restore User Defaults

Select this feature and press <Enter> to load the user's defaults previously saved in the system. When the dialog box appears, asking you if you want to restore user's defaults, select **Yes** to restore the user's defaults previously saved in the system, or select No to abandon the user's defaults that were previously saved.

Boot Override

Use this item to override the boot device priority sequence as listed in the Boot submenu, and select one of the devices listed below to boot the system instead. This is a one-time override.

#8100 ID0A LUN0 SEAGAGE ST9734,

#8100 ID43 LUN0 LSI LSI Logica,

#8100 ID0B LUN0 SEAGAGE ST9146,

IBA XE Slot 0100 v2208,

UEFI Built-in EFI Shell

Appendix A

System Specifications

Note: Unless noted specifications apply to a complete system (all serverboards). There are four motherboard drawer nodes per system.

Processors

One or two Intel® E5-2600 Series processors in LGA2011 sockets

Note: refer to our web site for details on supported processors and operating systems.

Chipset

Intel PCH C602

BIOS

128 Mb AMI BIOS® SM Flash BIOS

Memory Capacity

Sixteen memory slots that support up to 512 GB of ECC registered RDIMMs or up to 128 GB of unbuffered ECC/non-ECC UDIMMs at DDR3-1600/1333/1066/800 MHz speed and 1 GB, 2 GB, 4 GB, 8 GB, 16 GB or 32 GB size

Note: refer to Chapter 5 for details and to our web site for updates to supported memory.

SAS Controller

LSI 2308 SAS controller for eight-port SAS2, which supports RAID 0, 1, and 10 for F627G3-F73+ and F627G3-F73PT+ servers

SATA Controller

Intel chipset-based SATA controller for six-port SATA, which supports two SATA 3.0 ports (RAID 0 and 1) and four SATA 2.0 ports (RAID 0, 1, 5 and 10)

SAS/SATA Drive Bays

Each node of the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ contains two (2) hot-swap drive bays to house two standard 3.5" SAS/SATA drives

PCI Expansion

The FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ has 3x PCI-E 3.0 x16 and 2x PCI-E 3.0 x8 slots available per node

Serverboard

X9DRFF-iG+/iTG+/7G+/7TG+

Dimensions: (LxW) 8.54" x 18.72" (21.7 cm x 47.5 cm)

Chassis

F424AG-R1K62B (4U rackmount)

Dimensions: (WxHxD) 17.63 x 6.96 x 35 in. (448 x 177 x 889 mm)

Weight

Gross (Bare Bone): 150 lbs (68.04 kg)

System Cooling

The system has eight (8) 8-cm PWM system cooling fans in the chassis

System Input Requirements

AC Input: 1000W Output @ 100-120V, 12-10A, 50-60Hz
 1200W Output @ 120-140V, 12-10A, 50-60Hz
 1620W Output @ 180-240V, 10.5-8A, 50-60Hz

Efficiency: 95%+ (Platinum Level)

Power Supply

Rated Output Power: 1620 Watt (Part# PWS-1K62P-1R)

Rated Output Voltages: 1000W: +12V/84A; +5Vsb/4A
 1200W: +12V/100A; +5Vsb/4A
 1620W: +12V/150A; +5Vsb/4A

Operating Environment

Operating Temperature: 10°C to 35°C (50°F to 95°F)

Non-operating Temperature: -40°C to 70°C (-40°F to 158°F)

Operating Relative Humidity: 8% to 90% (non-condensing)

Non-operating Relative Humidity: 5 to 95% (non-condensing)

The table below specifies the preferred ambient temperature versus processor support for the FatTwin F627G3-FT+/FTPT+/F73+/F73PT+ system.

| Ambient Temperature versus Porcessor Support | | | |
|--|------------------|----------------|----------------|
| | 35°C | 30°C | 25°C |
| 130 W | X _{1,2} | X ₁ | X ₁ |
| 115 W | X _{1,2} | X ₁ | X ₁ |
| 95 W | X _{1,2} | X ₁ | X ₁ |

Note 1: Requires two 9.5k rpm inner fans per mode.

Note 2: Selective GPUs only.

Regulatory Compliance

Electromagnetic Emissions: FCC Class A, EN 55022 Class A, EN 61000-3-2/-3-3, CISPR 22 Class A

Electromagnetic Immunity: EN 55024/CISPR 24, (EN 61000-4-2, EN 61000-4-3, EN 61000-4-4, EN 61000-4-5, EN 61000-4-6, EN 61000-4-8, EN 61000-4-11)

Safety: CSA/EN/IEC/UL 60950-1 Compliant, UL or CSA Listed (USA and Canada), CE Marking (Europe)

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. "Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate" for further details.

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